TEXAS INSTRUMENTS

TPS38 ワイド V_{IN}、65V デュアル・チャネル過電圧 / 低電圧 (OV/UV) 検出器、プログラマブル・センス / リセット機能付き

1 特長

- 広い電源電圧範囲：2.7V〜65V
- 機能安全への対応を予定
  - 機能安全システムの設計に役立つ資料を利用可能
- 65V 定格の SENSE および RESET ピン
- 低静止電流：1µA (標準値)
- 電圧スレッショルドを柔軟にかつ幅広く選択可能
  表 10-1
  - 2.7V〜36V (誤差 1.5% 以下)
  - 800mV オプション (誤差 1% 以下)
- ヒステリシス内蔵 (V_{HYS})
  - パーセンテージ・オプション：2%〜13% (1% 刻み)
  - 固定オプション：V_{TH} < 8V = 0.5V、1V、1.5V、2V、2.5V
- リセット時間遅延をプログラム可能
  - 10nF = 12.8ms、10µF = 12.8s
- 検出時間遅延をプログラム可能
  - 10nF = 1.28ms、10µF = 1.28s
- マニュアル・リセット ($\overline{MR}$) 機能
- 出力トポロジ：
  - チャネル 1：オープン・ドレインまたはプッシュプル
  - チャネル 2：オープン・ドレイン

2 アプリケーション

- ゲートウェイ
- PLC
- I/O モジュール
- サーボ / AC モーター制御
- ファクトリ・オートメーション
- 電動工具

3 概要

TPS38 は、I_{DD} = 1µA、精度 1%、検出時間が 10µs と短い 65V 入力電圧検出器です。

このデバイスは 12V/24V 車載用バッテリ・システムに直接接続し、過電圧 (OV) または低電圧 (UV) 状態を継続的に監視できます。また、抵抗デバイダを内蔵しているため、ソリューション全体のサイズを最小化できます。コールド・クランク、スタート / ストップ、車の各種バッテリ電圧過渡の影響を受けないように、各種ヒステリシス電圧を選択できます。SENSE ピンに組み込まれたヒステリシスは、電源電圧レール監視中のリセット信号の誤検出を防止します。

VDD ピンと SENSE ピンが独立しているため、信頼性が高い車載用システムが求める冗長性を実現できます。また、SENSE は VDD よりも高い電圧と低い電圧を監視できます。SENSE ピンは高インピーダンス入力であるため、任意で外付け抵抗を使用できます。CTSx および CTRx ピンを使うことで、RESET 信号の立ち上がり / 立ち下がりエッジの遅延を調整できます。また、CTSx は、監視対象の電圧レールの電圧グリッチを無視するデバウンシング機能として機能します。CTRx は、システムを強制的にリセットするためのマニュアル・リセット ($\overline{MR}$) としても動作します。
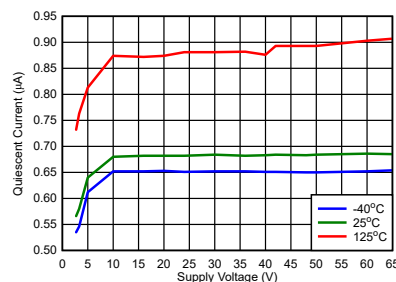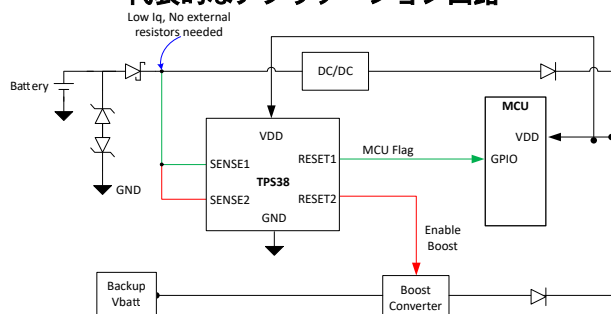
TPS38 は WSON または SOT-23 パッケージで供給されます。IEC60664 のガイドラインに基づいて VDD と GND との間の沿面距離を増やすため、中央パッドはどこにも接続されていません。TPS38 は –40℃〜+125℃の T_A で動作します。

製品情報

部品番号	パッケージ[1]	本体サイズ (公称)
TPS38	WSON (10) (DSK)	2.5mm × 2.5mm
TPS38	SOT-23 (14) (DYY)	4.1mm × 1.9mm

(1) パッケージの詳細については、このデータシートの末尾の外形図を参照してください。

代表的なアプリケーション回路

I_{DD} と V_{DD} との代表的な関係

English Data Sheet: SNVSBJ2

Table of Contents

4 Revision History

資料番号末尾の英字は改訂を表しています。その改訂履歴は英語版に準じています。

5 Device Comparison

Contact TI sales representatives or consult TI's E2E forum for details and availability; minimum order quantities may apply.

Voltage Threshold — CH 1, CH 2

Hysteresis — CH 1 CH 2

TPS38 X XX XX X X XXX R

Topology

Suffix	CH1	CH2
A	UV OD L	UV OD L
B	UV PP L	UV OD L
D	UV PP L	UV OD H
E	UV PP H	UV OD H
F	UV PP H	UV OD L
G	UV OD H	UV OD H
H	UV OD H	UV OD L
J	OV OD L	OV OD L

Suffix	CH1	CH2
M	OV PP L	OV OD L
N	OV PP L	OV OD H
O	OV PP H	OV OD H
P	OV PP H	OV OD L

Threshold Voltage

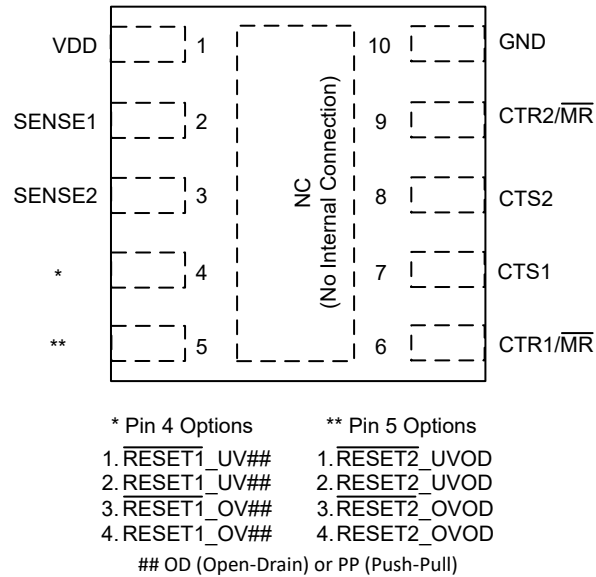| 100mV steps Suffix	VIT	Suffix	VIT	400mV steps Suffix	VIT	500mV steps Suffix	VIT	1V steps Suffix	VIT
01	800mV	70	7.0V	A0	10.4V	D0	20.5V	F0	31.0V
27	2.7V	71	7.1V	A1	10.8V	D1	21.0V	F1	32.0V
28	2.8V	72	7.2V	A2	11.2V	D2	21.5V	F2	33.0V
29	2.9V	73	7.3V	A3	11.6V	D3	22.0V	F3	34.0V
30	3.0V	74	7.4V	A4	12.0V	D4	22.5V	F4	35.0V
31	3.1V	75	7.5V	A5	12.4V	D5	23.0V	F5	36.0V
32	3.2V	76	7.6V	A6	12.8V	D6	23.5V		
33	3.3V	77	7.7V	A7	13.2V	D7	24.0V		
34	3.4V	78	7.8V	A8	13.6V	D8	24.5V		
35	3.5V	79	7.9V	A9	14.0V	D9	25.0V		
36	3.6V	80	8.0V	B0	14.4V	E0	25.5V		
37	3.7V	81	8.1V	B1	14.8V	E1	26.0V		
38	3.8V	82	8.2V	B2	15.2V	E2	26.5V		
39	3.9V	83	8.3V	B3	15.6V	E3	27.0V		
40	4.0V	84	8.4V	B4	16.0V	E4	27.5V		
41	4.1V	85	8.5V	B5	16.4V	E5	28.0V		
42	4.2V	86	8.6V	B6	16.8V	E6	28.5V		
43	4.3V	87	8.7V	B7	17.2V	E7	29.0V		
44	4.4V	88	8.8V	B8	17.6V	E8	29.5V		
45	4.5V	89	8.9V	B9	18.0V	E9	30.0V		
46	4.6V	90	9.0V	C0	18.4V				
47	4.7V	91	9.1V	C1	18.8V				
48	4.8V	92	9.2V	C2	19.2V				
49	4.9V	93	9.3V	C3	19.6V				
50	5.0V	94	9.4V	C4	20.0V				
51	5.1V	95	9.5V						
52	5.2V	96	9.6V						
53	5.3V	97	9.7V						
54	5.4V	98	9.8V						
55	5.5V	99	9.9V						
56	5.6V	00	10.0V						
57	5.7V								
58	5.8V								
59	5.9V								
60	6.0V								
61	6.1V								
62	6.2V								
63	6.3V								
64	6.4V								
65	6.5V								
66	6.6V								
67	6.7V								
68	6.8V								
69	6.9V								

Hysteresis

Suffix	CH1
2	2%
3	3%
4	4%
5	5%
6	6%
7	7%
8	8%
9	9%
A	10%
B	11%
C	12%
D	13%
E	0.5V
F	1V
G	1.5V
H	2V
I	2.5V

Package

Suffix	Name
DSK	WSON
DYY	SOT-23

Reel

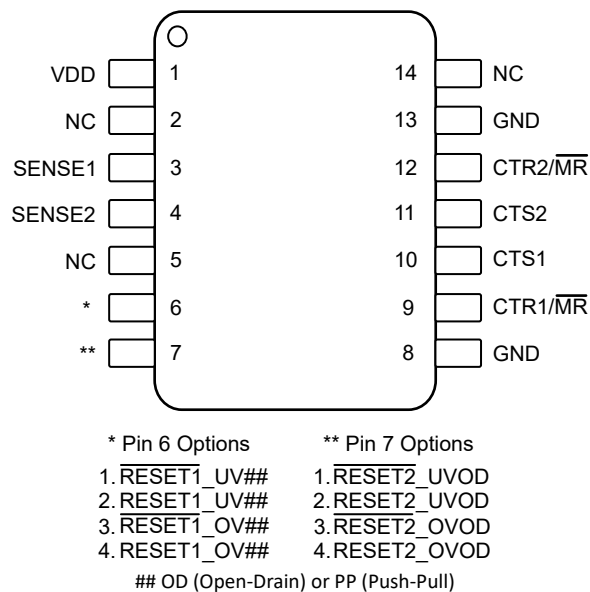| Suffix	Name
R	Large

図 5-1. Device Nomenclature

1. Sense logic: OV = overvoltage; UV = undervoltage
2. Reset topology: PP = Push-Pull; OD = Open-Drain
3. Reset logic: L = Active-Low; H = Active-High
4. A to I hysteresis options are only available for 2.7 V to 8 V threshold options

6 Pin Configuration and Functions

```
VDD      [ 1        10 ]  GND

SENSE1   [ 2         9 ]  CTR2/MR̄

SENSE2   [ 3    NC   8 ]  CTS2
              (No Internal Connection)
*        [ 4         7 ]  CTS1

**       [ 5         6 ]  CTR1/MR̄
```

* Pin 4 Options	** Pin 5 Options
1. RESET1_UV##	1. RESET2_UVOD
2. RESET1_UV##	2. RESET2_UVOD
3. RESET1_OV##	3. RESET2_OVOD
4. RESET1_OV##	4. RESET2_OVOD

OD (Open-Drain) or PP (Push-Pull)

**図 6-1. DSK Package,
10-Pin WSON,
TPS38 (Top View)**

```
VDD    [ 1        14 ]  NC
NC     [ 2        13 ]  GND
SENSE1 [ 3        12 ]  CTR2/MR̄
SENSE2 [ 4        11 ]  CTS2
NC     [ 5        10 ]  CTS1
*      [ 6         9 ]  CTR1/MR̄
**     [ 7         8 ]  GND
```

* Pin 6 Options	** Pin 7 Options
1. RESET1_UV##	1. RESET2_UVOD
2. RESET1_UV##	2. RESET2_UVOD
3. RESET1_OV##	3. RESET2_OVOD
4. RESET1_OV##	4. RESET2_OVOD

OD (Open-Drain) or PP (Push-Pull)

**図 6-2. DYY Package,
14-Pin SOT-23,
TPS38 (Top View)**

Product Folder Links: *TPS38*

English Data Sheet: SNVSBJ2

表 6-1. Pin Functions

PIN NAME	WSON (DSK) PIN NUM.	SOT23 (DYY) PIN NUM.	I/O	DESCRIPTION
VDD	1	1	I	**Input Supply Voltage:** Bypass with a 0.1 µF capacitor to GND.
SENSE1	2	3	I	This pin is connected to the voltage that will be monitored for fixed variants or to a resistor divider for the adjustable variant. Depending on the SENSE1 sensing configuration, when the voltage on SENSE1 pin detects an undervoltage (UV) or an overvoltage (OV) fault, $\overline{RESET1}$/RESET1 asserts after the sense time delay, set by CTS1. When the voltage on the SENSE1 pin transitions back to an unfaulty UV or OV state, $\overline{RESET1}$/RESET1 deasserts after the reset time delay, set by CTR1. For noisy applications, placing a 10 nF to 100 nF ceramic capacitor close to this pin may be needed for optimum performance.
SENSE2	3	4	I	This pin is connected to the voltage that will be monitored for fixed variants or to a resistor divider for the adjustable variant. Depending on the SENSE2 sensing configuration, when the voltage on SENSE2 pin detects an undervoltage (UV) or an overvoltage (OV) fault, $\overline{RESET2}$/RESET2 asserts after the sense time delay, set by CTS2. When the voltage on the SENSE2 pin transitions back to an unfaulty UV or OV state, $\overline{RESET2}$/RESET2 deasserts after the reset time delay, set by CTR2. For noisy applications, placing a 10 nF to 100 nF ceramic capacitor close to this pin may be needed for optimum performance.
$\overline{RESET1}$/ RESET1	4	6	O	**Output Reset Signal For Channel 1:** See セクション 5 for output topology options. $\overline{RESET1}$/RESET1 asserts when SENSE1 detects an undervoltage or overvoltage fault condition. $\overline{RESET1}$/RESET1 remains asserted for the reset time delay period after SENSE1 transitions out of an UV or OV fault condition. For active low open-drain reset output, an external pullup resistor is required. Do not place external pullup resistors on push-pull outputs. Reset output signal for: **SENSE1** Sensing Topology: **Undervoltage (UV) or Overvoltage (OV)** Output topology: **Open Drain or Push Pull, Active Low or Active High**
$\overline{RESET2}$/ RESET2	5	7	O	**Output Reset Signal For Channel 2:** See セクション 5 for output topology options. $\overline{RESET2}$/RESET2 asserts when SENSE2 detects an undervoltage or overvoltage fault condition. $\overline{RESET2}$/RESET2 remains asserted for the reset time delay period after SENSE2 transitions out of an UV or OV fault condition. For active low open-drain reset output, an external pullup resistor is required. Reset output signal for: **SENSE2** Sensing Topology: **Undervoltage (UV) or Overvoltage (OV)** Output topology: **Open Drain, Active Low or Active High**
CTR1/ $\overline{MR}$	6	9	-	**Channel 1 RESET Time Delay:** User-programmable reset time delay for $\overline{RESET1}$/RESET1. Connect an external capacitor for adjustable time delay or leave the pin floating for the shortest delay. **Manual Reset:** If this pin is driven low, the $\overline{RESET1}$/RESET1 output will reset and become asserted. The pin can be left floating or be connected to a capacitor. This pin should not be driven high.
CTR2/ $\overline{MR}$	9	12	-	**Channel 2 RESET Time Delay:** User-programmable reset time delay for $\overline{RESET2}$/RESET2. Connect an external capacitor for adjustable time delay or leave the pin floating for the shortest delay. **Manual Reset:** If this pin is driven low, the $\overline{RESET2}$/RESET2 output will reset and become asserted. The pin can be left floating or be connected to a capacitor. This pin should not be driven high.
GND	10	8, 13	-	**Ground.** All GND pins must be electrically connected to the board ground.
NC	PAD	2, 5, 14	-	The PAD for the **DSK** package is not internally connected, the PAD can be connected to GND or be left floating. For the **DYY** package, NC stands for "No Connect". The pins are to be left floating.
CTS1	7	10	O	**Channel 1 SENSE Time Delay:** Capacitor programmable sense delay: CTS1 pin offers a user-adjustable sense delay time when asserting a reset condition. Connecting this pin to a ground-referenced capacitor sets the $\overline{RESET1}$/RESET1 delay time to assert.
CTS2	8	11	O	**Channel 2 SENSE Time Delay:** Capacitor programmable sense delay: CTS2 pin offers a user-adjustable sense delay time when asserting a reset condition. Connecting this pin to a ground-referenced capacitor sets the $\overline{RESET2}$/RESET2 delay time to assert.

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表 6-2. Pin Functions Generic

PIN		I/O	DESCRIPTION
NAME	NO.		
VDD	1	I	**Input Supply Voltage.**
SENSE1	2	I	Input for the monitored supply voltage rail channel 1
SENSE2	3	I	Input for the monitored supply voltage rail channel 2
RESET1 $\overline{\text{RESET1}}$,	4	O	**Output Reset Signal For Channel 1**: See 図 5-1
RESET2 $\overline{\text{RESET2}}$,	5	O	**Output Reset Signal For Channel 2**: See 図 5-1
CTR1/ $\overline{\text{MR}}$	6	–	**Capacitor Time Delay Reset 1**. The CTR1 pin offers a user-programmable reset release delay for Reset1. Connect an external capacitor on this pin to adjust time delay. When not in use leave pin floating for the fastest time delay. **Manual Reset (CTR1/ $\overline{\text{MR}}$):**If this pin is driven low the RESET1 output will reset, leave pin floating or connected to a cap to release reset. This pin should not be driven high.
CTR2/ $\overline{\text{MR}}$	9	–	**Capacitor Time Delay Reset 2**. The CTR2 pin offers a user-programmable reset release delay for Reset2. Connect an external capacitor on this pin to adjust time delay. When not in use leave pin floating for the fastest time delay. **Manual Reset (CTR2/ $\overline{\text{MR}}$):**If this pin is driven low the RESET2 output will reset, leave pin floating or connected to a cap to release reset. This pin should not be driven high.
GND	10	–	**Ground**
NC	PAD	-	Not internally connected, is recommended to leave the central pad floating for wider creepage between VDD and GND.
CTS1	7	–	**Capacitor Time Delay Sense 1**. The CTS1 pin offers a user-programmable sense delay for Sense1. Connect an external capacitor on this pin to adjust time delay. When not in use leave pin floating for the fastest time delay.
CTS2	8	–	**Capacitor Time Delay Sense 2**. The CTS2 pin offers a user-programmable sense delay for Sense2. Connect an external capacitor on this pin to adjust time delay. When not in use leave pin floating for the fastest time delay.
TPS38A			
$\overline{\text{RESET1}}$_UVOD	4	O	Reset output signal for Sense 1. Topology: Undervoltage, Open Drain, Active Low topology.
$\overline{\text{RESET2}}$_UVOD	5	O	Reset output signal for Sense 2. Topology: Undervoltage, Open Drain, Active Low topology.
TPS38B			
$\overline{\text{RESET1}}$_UVPP	4	O	Reset output signal for Sense 1. Topology: Undervoltage, Push Pull, Active Low topology.
$\overline{\text{RESET2}}$_UVOD	5	O	Reset output signal for Sense 2. Topology: Undervoltage, Open Drain, Active Low topology.
TPS38D			
$\overline{\text{RESET1}}$_UVPP	4	O	Reset output signal for Sense 1. Topology: Undervoltage, Push Pull, Active Low topology.
RESET2_UVOD	5	O	Reset output signal for Sense 2. Topology: Undervoltage, Open Drain, Active High topology.
TPS38E			
RESET1_UVPP	4	O	Reset output signal for Sense 1. Topology: Undervoltage, Push Pull, Active High topology.
RESET2_UVOD	5	O	Reset output signal for Sense 2. Topology: Undervoltage, Open Drain, Active High topology.
TPS38F			
RESET1_UVPP	4	O	Reset output signal for Sense 1. Topology: Undervoltage, Push Pull, Active High topology.
$\overline{\text{RESET2}}$_UVOD	5	O	Reset output signal for Sense 2. Topology: Undervoltage, Open Drain, Active Low topology.
TPS38G			
RESET1_UVOD	4	O	Reset output signal for Sense 1. Topology: Undervoltage, Open Drain, Active High topology.
RESET2_UVOD	5	O	Reset output signal for Sense 2. Topology: Undervoltage, Open Drain, Active High topology.
TPS38H			
RESET1_UVOD	4	O	Reset output signal for Sense 1. Topology: Undervoltage, Open Drain, Active High topology.
$\overline{\text{RESET2}}$_UVOD	5	O	Reset output signal for Sense 2. Topology: Undervoltage, Open Drain, Active Low topology.

Product Folder Links: *TPS38*

English Data Sheet: *SNVSBJ2*

表 6-2. Pin Functions Generic (continued)

PIN		I/O	DESCRIPTION
NAME	NO.		
TPS38J			
RESET1_OVOD	4	O	Reset output signal for Sense 1. Topology: Overvoltage, Open Drain, Active Low topology.
RESET2_OVOD	5	O	Reset output signal for Sense 2. Topology: Overvoltage, Open Drain, Active Low topology.
TPS38M			
RESET1_OVPP	4	O	Reset output signal for Sense 1. Topology: Overvoltage, Push Pull, Active Low topology.
RESET2_OVOD	5	O	Reset output signal for Sense 2. Topology: Overvoltage, Open Drain, Active Low topology.
TPS38N			
RESET1_OVPP	4	O	Reset output signal for Sense 1. Topology: Overvoltage, Push Pull, Active Low topology.
RESET2_OVOD	5	O	Reset output signal for Sense 2. Topology: Overvoltage, Open Drain, Active High topology.
TPS38O			
RESET1_OVPP	4	O	Reset output signal for Sense 1. Topology: Overvoltage, Push Pull, Active High topology.
RESET2_OVOD	5	O	Reset output signal for Sense 2. Topology: Overvoltage, Open Drain, Active High topology.
TPS38P			
RESET1_OVPP	4	O	Reset output signal for Sense 1. Topology: Overvoltage, Push Pull, Active High topology.
RESET2_OVOD	5	O	Reset output signal for Sense 2. Topology: Overvoltage, Open Drain, Active Low topology.

Product Folder Links: TPS38

English Data Sheet: SNVSBJ2

7 Specifications

7.1 Absolute Maximum Ratings

over operating free-air temperature range, unless otherwise noted [1]

		MIN	MAX	UNIT
Voltage	VDD, V_{SENSE1}, V_{SENSE2}, V_{RESET1}, V_{RESET2}, $V_{\overline{RESET1}}$, $V_{\overline{RESET2}}$	−0.3	70	V
Voltage	V_{CTS1}, V_{CTS2}, V_{CTR1}, V_{CTR2}	−0.3	6	V
Current	I_{RESET1}, I_{RESET2}, $I_{\overline{RESET1}}$, $I_{\overline{RESET2}}$		10	mA
Temperature [2]	Operating junction temperature, T_J	−40	150	°C
Temperature [2]	Operating Ambient temperature, T_A	−40	150	°C
Temperature [2]	Storage, T_{stg}	−65	150	°C

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) As a result of the low dissipated power in this device, it is assumed that $T_J = T_A$.

7.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 [1]	± 2000	V
		Charged device model (CDM), per JEDEC specification JESD22-C101 [2]	± 750	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
Voltage	V_{DD}	2.7		65	V
Voltage	V_{SENSE1}, V_{SENSE2}, V_{RESET1}, V_{RESET2}, $V_{\overline{RESET1}}$, $V_{\overline{RESET2}}$	0		65	V
Voltage	V_{CTS1}, V_{CTS2}, V_{CTR1}, V_{CTR2}	0		5.5	V
Current	I_{RESET1}, I_{RESET2}, $I_{\overline{RESET1}}$, $I_{\overline{RESET2}}$	0		±5	mA
T_J	Junction temperature (free air temperature)	−40		125	°C

7.4 Thermal Information

	THERMAL METRIC [1]	TPS38 DSK 10-PIN	TPS38 DYY 14-PIN	UNIT
$R_{\theta JA}$	Junction-to-ambient thermal resistance	87.4	131.5	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	76.3	61.6	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	54.2	56.6	°C/W
ψ_{JT}	Junction-to-top characterization parameter	4.8	3.4	°C/W
ψ_{JB}	Junction-to-board characterization parameter	54.2	56.5	°C/W
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	34.8	N/A	°C/W

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

7.5 Electrical Characteristics

At $V_{DD(MIN)} \leq V_{DD} \leq V_{DD\ (MAX)}$, CTR1/$\overline{MR}$ = CTR2/$\overline{MR}$ = CTS1 = CTS2 = open, output reset pull-up resistor R_{PU} = 10 kΩ, voltage V_{PU} = 5.5 V, and load C_{LOAD} = 10 pF. The operating free-air temperature range T_A = – 40°C to 125°C, unless otherwise noted. Typical values are at T_A = 25°C and VDD = 16 V and V_{IT} = 6.5 V (V_{IT} refers to V_{ITN} or V_{ITP}).

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
VDD						
V_{DD}	Supply Voltage		2.7		65	V
UVLO [1]	Undervoltage Lockout	V_{DD} Falling below $V_{DD\ (MIN)}$			2.7	V
V_{POR}	Power on Reset Voltage [2] $\overline{RESET}$, Active Low (Open-Drain, Push-Pull)	$V_{OL(MAX)}$ = 300 mV $I_{OUT\ (Sink)}$ = 15 µA			1.4	V
V_{POR}	Power on Reset Voltage [2] RESET, Active High (Push-Pull)	$V_{OH(MIN)}$ = 0.8 x V_{DD} $I_{OUT\ (Source)}$ = 15 µA			1.4	V
I_{DD}	Supply current into VDD pin	V_{IT} = 800 mV $V_{DD\ (MIN)} \leq V_{DD} \leq V_{DD\ (MAX)}$		1	2.6	µA
		V_{IT} = 2.7 V to 36 V $V_{DD\ (MIN)} \leq V_{DD} \leq V_{DD\ (MAX)}$		1	2	µA
SENSE (Input)						
I_{SENSE}	Input current (SENSE1, SENSE2)	V_{IT} = 800 mV			100	nA
I_{SENSE}	Input current (SENSE1, SENSE2)	V_{IT} < 10 V			0.8	µA
I_{SENSE}	Input current (SENSE1, SENSE2)	10 V < V_{IT} < 26 V			1.2	µA
I_{SENSE}	Input current (SENSE1, SENSE2)	V_{IT} > 26 V			2	µA
V_{ITN}	Input Threshold Negative (Undervoltage)	V_{IT} = 2.7 V to 36 V	-1.5		1.5	%
		V_{IT} = 800 mV [3]	0.792	0.800	0.808	V
V_{ITP}	Input Threshold Positive (Overvoltage)	V_{IT} = 2.7 V to 36 V	-1.5		1.5	%
		V_{IT} = 800 mV [3]	0.792	0.800	0.808	V
V_{HYS}	Hysteresis Accuracy [4]	V_{IT} = 0.8 V and 2.7 V to 36 V V_{HYS} Range = 2% to 13% (1% step)	-1.5		1.5	%
		V_{IT} = 2.7 V to 8 V V_{HYS} = 0.5 V, 1 V, 1.5 V, 2 V, 2.5 V (V_{ITP} - V_{HYS}) ≥ 2.4 V, OV Only	-1.5		1.5	%
RESET (Output)						
$I_{lkg(OD)}$	Open-Drain leakage (RESET1, RESET2)	V_{RESET} = 5.5 V V_{ITN} < V_{SENSE} < V_{ITP}			300	nA
		V_{RESET} = 65 V V_{ITN} < V_{SENSE} < V_{ITP}			300	nA
V_{OL} [5]	Low level output voltage	2.7 V ≤ VDD ≤ 65 V I_{RESET} = 5 mA			300	mV
V_{OH_DO}	High level output voltage dropout (V_{DD} - V_{OH} = V_{OH_DO}) (Push-Pull only)	2.7 V ≤ VDD ≤ 65 V I_{RESET} = 500 uA			100	mV
V_{OH} [5]	High level output voltage (Push-Pull only)	2.7 V ≤ VDD ≤ 65 V I_{RESET} = 5 mA	0.8V_{DD}			V

Product Folder Links: TPS38

English Data Sheet: SNVSBJ2

7.5 Electrical Characteristics (continued)

At $V_{DD(MIN)} \le V_{DD} \le V_{DD\ (MAX)}$, CTR1/$\overline{MR}$ = CTR2/$\overline{MR}$ = CTS1 = CTS2 = open, output reset pull-up resistor R_{PU} = 10 kΩ, voltage V_{PU} = 5.5 V, and load C_{LOAD} = 10 pF. The operating free-air temperature range T_A = – 40°C to 125°C, unless otherwise noted. Typical values are at T_A = 25°C and VDD = 16 V and V_{IT} = 6.5 V (V_{IT} refers to V_{ITN} or V_{ITP}).

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
Capacitor Timing (CTS, CTR)						
R_{CTR}	Internal resistance (CTR1 / $\overline{MR}$, CTR2 / $\overline{MR}$)		877	1000	1147	Kohms
R_{CTS}	Internal resistance (C_{TS1}, C_{TS2})		88	100	122	Kohms
Manual Reset ($\overline{MR}$)						
$V_{\overline{MR}\_IH}$	CTR1 / $\overline{MR}$ and CTR2 / $\overline{MR}$ pin logic high input	VDD = 2.7 V	2200			mV
$V_{\overline{MR}\_IH}$	CTR1 / $\overline{MR}$ and CTR2 / $\overline{MR}$ pin logic high input	VDD = 65 V	2500			mV
$V_{\overline{MR}\_IL}$	CTR1 / $\overline{MR}$ and CTR2 / $\overline{MR}$ pin logic low input	VDD = 2.7 V			1300	mV
$V_{\overline{MR}\_IL}$	CTR1 / $\overline{MR}$ and CTR2 / $\overline{MR}$ pin logic low input	VDD = 65 V			1300	mV

(1) When V_{DD} voltage falls below UVLO, reset is asserted for Output 1 and Output 2. V_{DD} slew rate ≤ 100 mV / μs
(2) V_{POR} is the minimum V_{DD} voltage for a controlled output state. Below VPOR, the output cannot be determined. V_{DD} dv/dt ≤ 100mV/μs
(3) For adjustable voltage guidelines and resistor selection refer to **Adjustable Voltage Thresholds** in **Application and Implementation section**
(4) Hysteresis is with respect to V_{ITP} and V_{ITN} voltage threshold. V_{ITP} has negative hysteresis and V_{ITN} has positive hysteresis.
(5) For V_{OH} and V_{OL} relation to output variants refer to **Timing Figures after the Timing Requirement Table**

7.6 Timing Requirements

At $V_{DD(MIN)} \le V_{DD} \le V_{DD\,(MAX)}$, CTR1/$\overline{MR}$ = CTR2/$\overline{MR}$ = CTS1 = CTS2 = open [1], output reset pull-up resistor R_{PU} = 10 kΩ, voltage V_{PU} = 5.5V, and C_{LOAD} = 10 pF. VDD and SENSE slew rate = 1V / μs. The operating free-air temperature range T_A = – 40°C to 125°C, unless otherwise noted. Typical values are at T_A = 25°C and VDD = 16 V and V_{IT} = 6.5 V (V_{IT} refers to either V_{ITN} or V_{ITP}).

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
Common timing parameters						
t_{CTR}	Reset release time delay (CTR1/$\overline{MR}$, CTR2/$\overline{MR}$) [2]	VIT = 2.7 V to 36 V C_{CTR1} = C_{CTR2} = Open 20% Overdrive from Hysteresis			100	μs
		VIT = 800 mV C_{CTR1} = C_{CTR2} = Open 20% Overdrive from Hysteresis			40	μs
t_{CTS}	Sense detect time delay (CTS1, CTS2) [3]	VIT = 2.7 V to 36 V C_{CTS1} = C_{CTS2} = Open 20% Overdrive from V_{IT}		34	90	μs
		VIT = 800 mV C_{CTS1} = C_{CTS2} = Open 20% Overdrive from V_{IT}		8	17	μs
t_{SD}	Startup Delay [4]	$C_{CTR1/\overline{MR}}$ = $C_{CTR2/\overline{MR}}$ = Open			2	ms

(1) C_{CTR1} = Reset delay channel 1, C_{CTR2} = Reset delay channel 2,
    C_{CTS1} = Sense delay channel 1, C_{CTS2} = Sense delay channel 2
(2) **CTR Reset detect time delay:**
    Overvoltage active-LOW output is measure from $V_{ITP\,-\,HYS}$ to V_{OH}
    Undervoltage active-LOW output is measure from $V_{ITN\,+\,HYS}$ to V_{OH}
    Overvoltage active-HIGH output is measure from $V_{ITP\,-\,HYS}$ to V_{OL}
    Undervoltage active-HIGH output is measure from $V_{ITN\,+\,HYS}$ to V_{OL}
(3) **CTS Sense detect time delay:**
    Active-low output is measure from V_{IT} to V_{OL} (or V_{Pullup})
    Active-high output is measured from V_{IT} to V_{OH}
    V_{IT} refers to either V_{ITN} or V_{ITP}
(4) During the power-on sequence, VDD must be at or above $V_{DD\,(MIN)}$ for at least t_{SD} before the output is in the correct state based on V_{SENSE}.
    t_{SD} time includes the propagation delay (C_{CTR1} = C_{CTR2} = Open). Capacitor in C_{CTR1} or C_{CTR2} will add time to t_{SD}.

7.7 Timing Diagrams
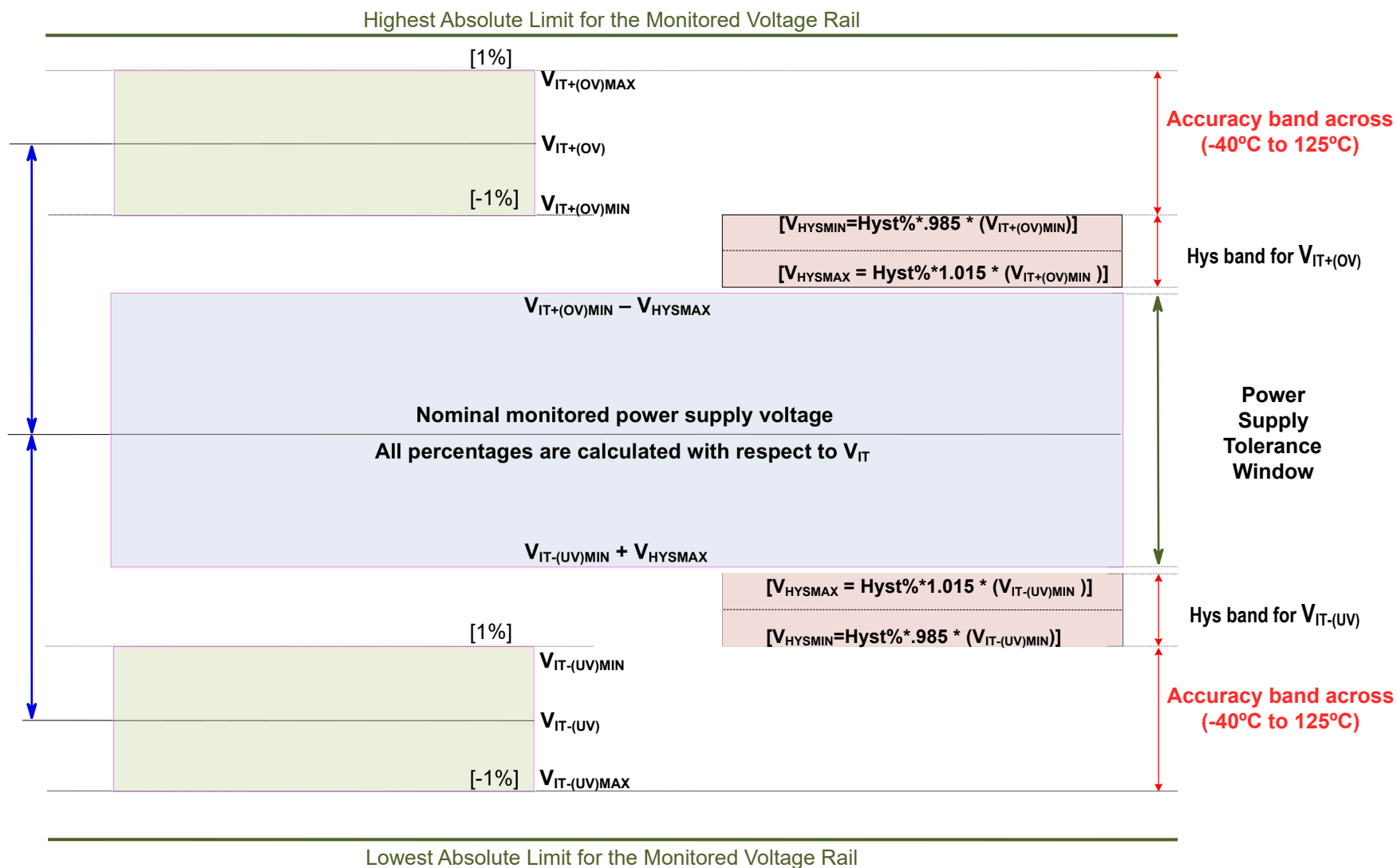
図 7-1. Voltage Threshold and Hysteresis Accuracy

Product Folder Links: *TPS38*

English Data Sheet: SNVSBJ2
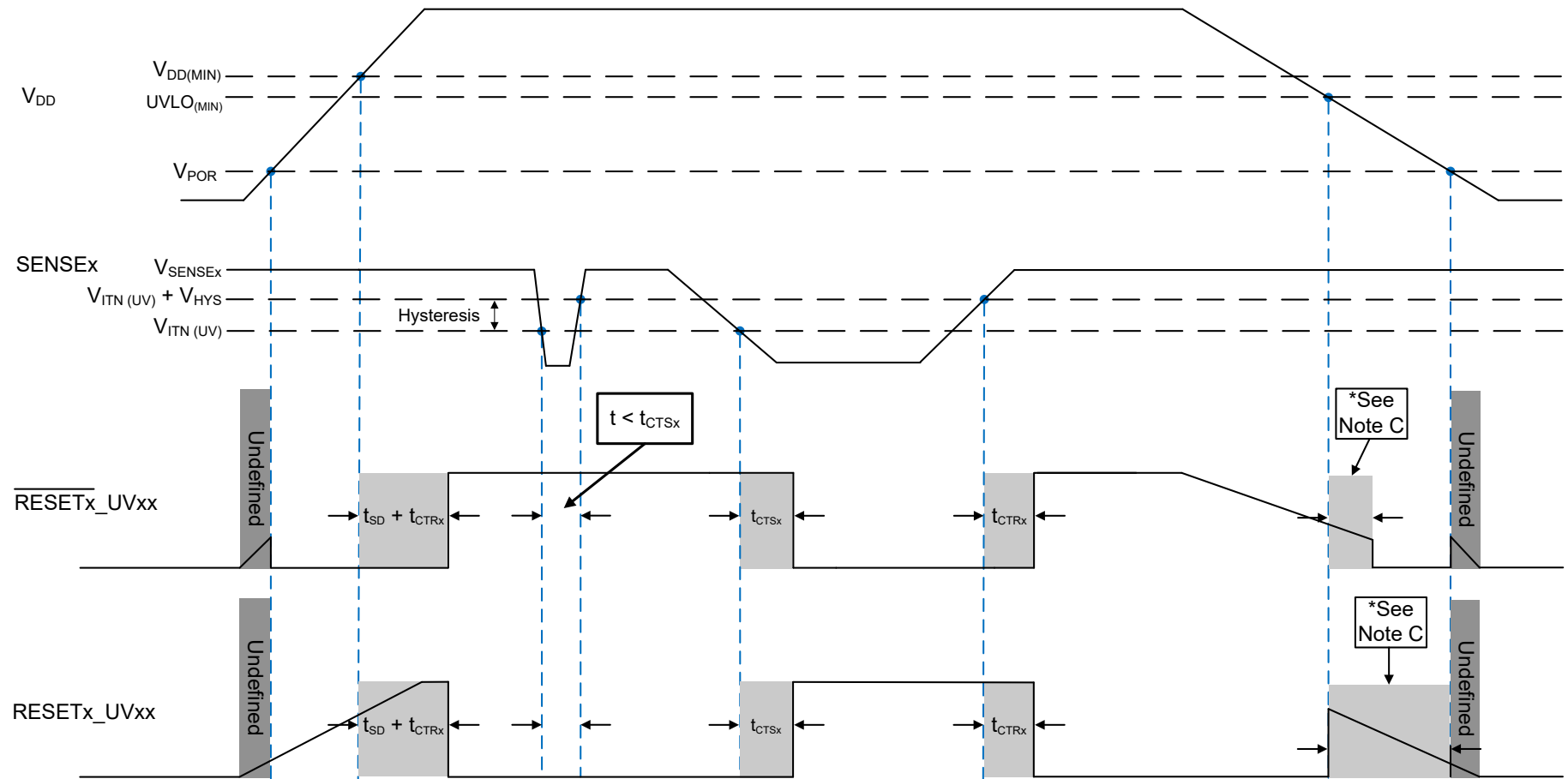
A. For open-drain output option, the timing diagram assumes the $\overline{\text{RESETx\_UVOD}}$ / RESETx_UVOD pin is connected via an external pull-up resistor to VDD.

B. Be advised that 図 7-2 shows the VDD falling slew rate is slow or the VDD decay time is much larger than the propagation detect delay (t_{CTRx}) time.

C. $\overline{\text{RESETx\_UVxx}}$ / RESETx_UVxx is asserted when VDD goes below the $UVLO_{(MIN)}$ threshold after the time delay, t_{CTRx}, is reached.

図 7-2. SENSEx Undervoltage (UV) Timing Diagram
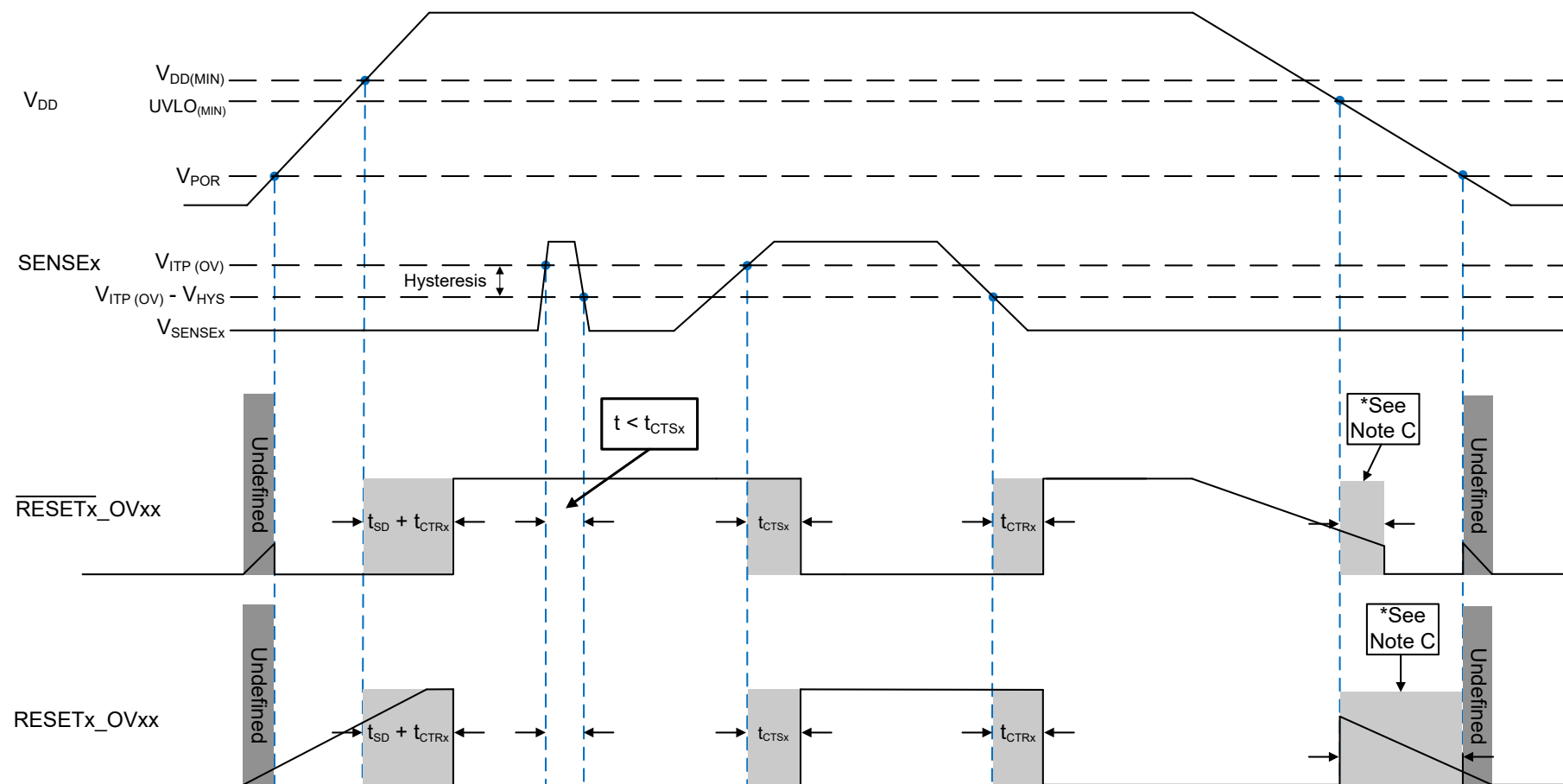
A. For open-drain output option, the timing diagram assumes the $\overline{\text{RESETx\_OVOD}}$ / RESETx_OVOD pin is connected via an external pull-up resistor to VDD.

B. Be advised that 図 7-3 shows the VDD falling slew rate is slow or the VDD decay time is much larger than the propagation detect delay (t_{CTRx}) time.

C. $\overline{\text{RESETx\_OVxx}}$ / RESETx_OVxx is asserted when VDD goes below the UVLO$_{(MIN)}$ threshold after the time delay, t_{CTRx}, is reached.

図 7-3. SENSEx Overvoltage (OV) Timing Diagram

7.8 Typical Characteristics

Typical characteristics show the typical performance of the TPS38 device. Test conditions are T_A = 25°C, R_{PU} = 100 kΩ, C_{Load} = 50 pF, unless otherwise noted.

$\overline{RESET}$ = High, V_{IT} = 2.7 V

図 7-4. V_{DD} vs I_{DD} ($\overline{RESET}$ = High, V_{IT} = 2.7 V)
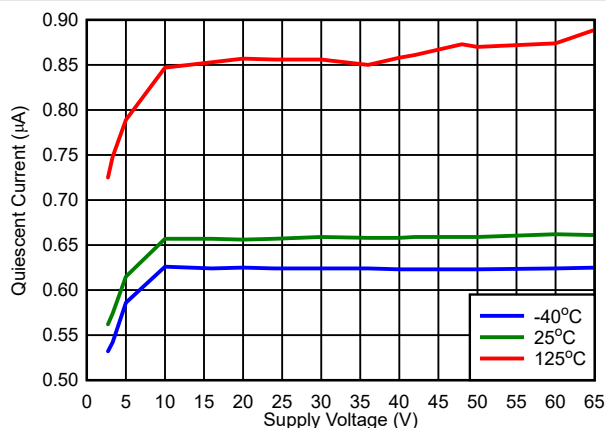
$\overline{RESET}$ = Low, V_{IT} = 2.7 V

図 7-5. V_{DD} vs I_{DD} ($\overline{RESET}$ = Low, V_{IT} = 2.7 V)
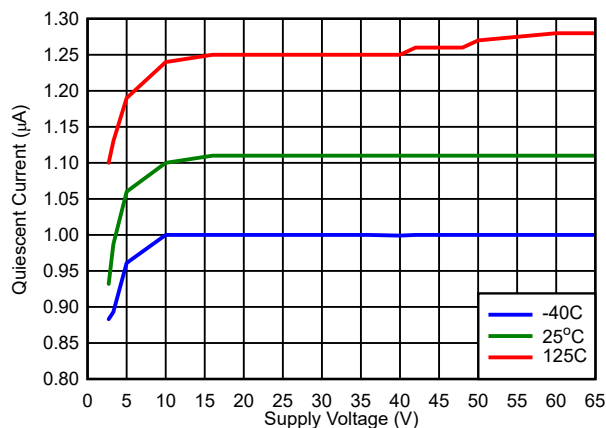
$\overline{RESET}$ = High, V_{IT} = 0.8 V

図 7-6. V_{DD} vs I_{DD} ($\overline{RESET}$ = High, V_{IT} = 0.8 V)
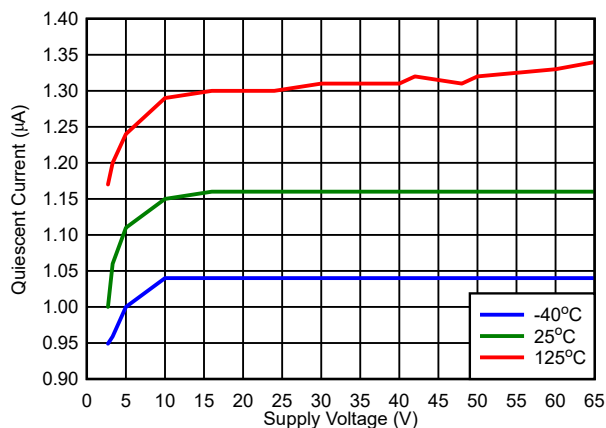
$\overline{RESET}$ = Low, V_{IT} = 0.8 V

図 7-7. V_{DD} vs I_{DD} ($\overline{RESET}$ = Low, V_{IT} = 0.8 V)
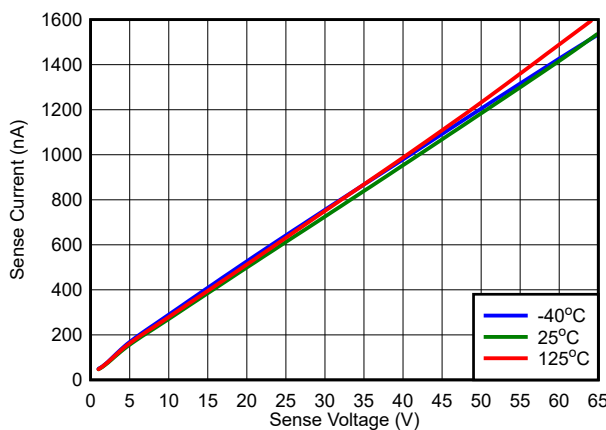
V_{DD} = 2.7 V

図 7-8. V_{SENSE} vs I_{SENSE}
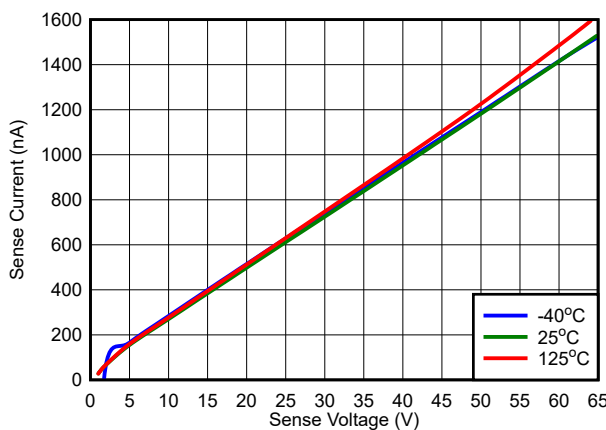
V_{DD} = 65 V

図 7-9. V_{SENSE} vs I_{SENSE}

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7.8 Typical Characteristics (continued)

Typical characteristics show the typical performance of the TPS38 device. Test conditions are $T_A = 25°C$, $R_{PU} = 100\ k\Omega$, $C_{Load} = 50\ pF$, unless otherwise noted.

$V_{DD} = 2.7\ V$
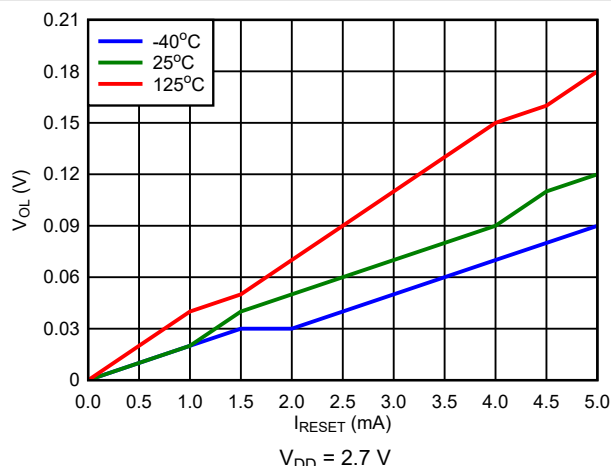
図 7-10. Open-Drain Active Low V_{OL} vs I_{RESET}

$V_{DD} = 65\ V$
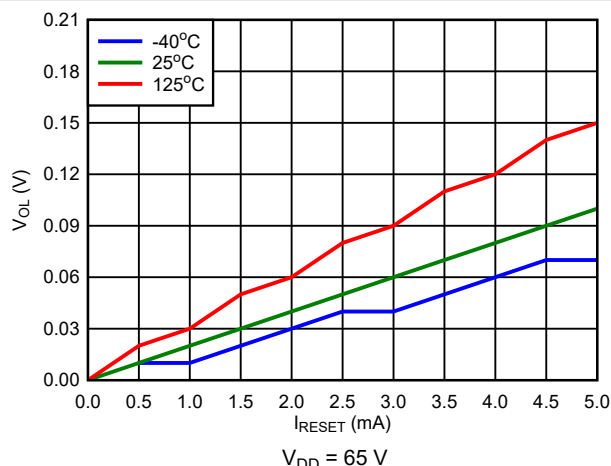
図 7-11. Open-Drain Active Low V_{OL} vs I_{RESET}

$V_{DD} = 2.7\ V$
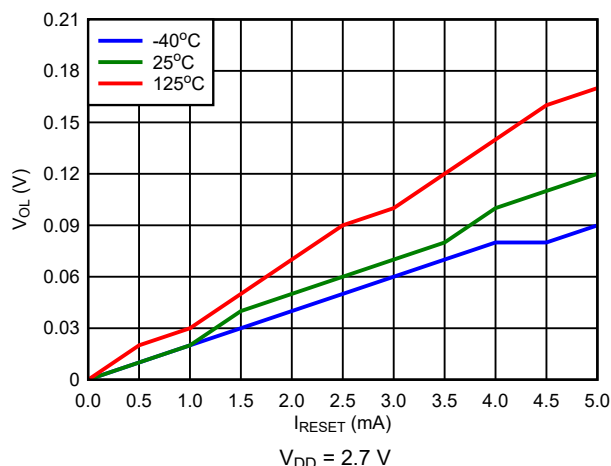
図 7-12. Open-Drain Active High V_{OL} vs I_{RESET}

$V_{DD} = 65\ V$
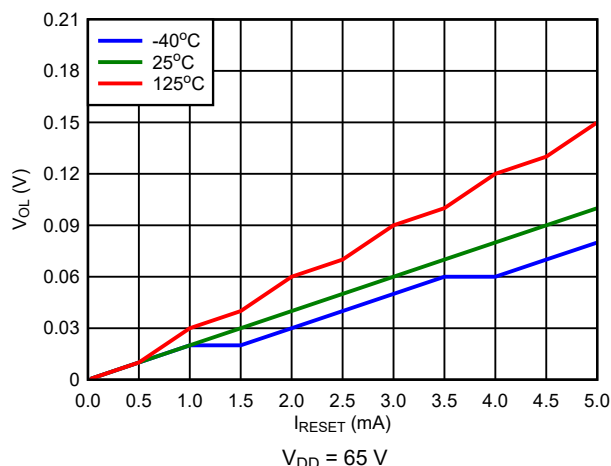
図 7-13. Open-Drain Active High V_{OL} vs I_{RESET}

$V_{DD} = 2.7\ V$
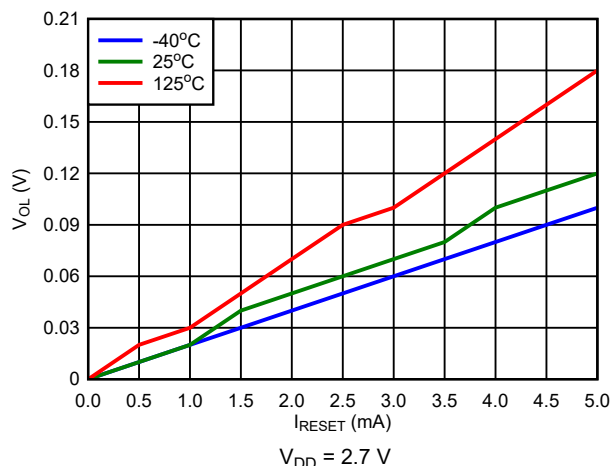
図 7-14. Push-Pull Active High V_{OL} vs I_{RESET}

$V_{DD} = 65\ V$

図 7-15. Push-Pull Active High V_{OL} vs I_{RESET}

Product Folder Links: *TPS38*

English Data Sheet: *SNVSBJ2*

7.8 Typical Characteristics (continued)

Typical characteristics show the typical performance of the TPS38 device. Test conditions are T_A = 25°C, R_{PU} = 100 kΩ, C_{Load} = 50 pF, unless otherwise noted.

図 7-16. Open-Drain Active Low V_{OL} vs V_{DD}

図 7-17. Open-Drain Active High V_{OL} vs V_{DD}
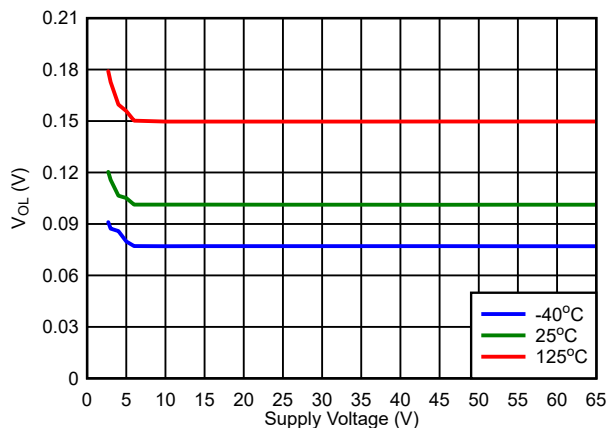
図 7-18. Push-Pull Active Low V_{OL} vs V_{DD}
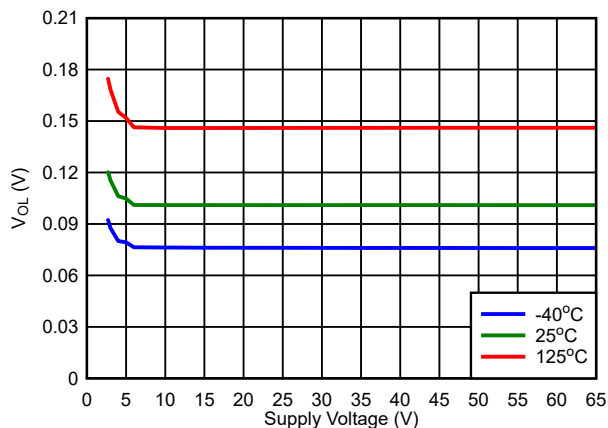
図 7-19. Push-Pull Active High V_{OL} vs V_{DD}

図 7-20. T_{CTS} vs C_{CTS}

図 7-21. T_{CTR} vs C_{CTR}

Product Folder Links: *TPS38*

English Data Sheet: *SNVSBJ2*
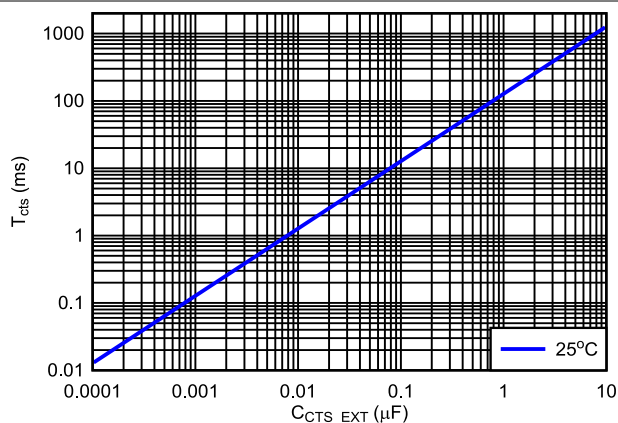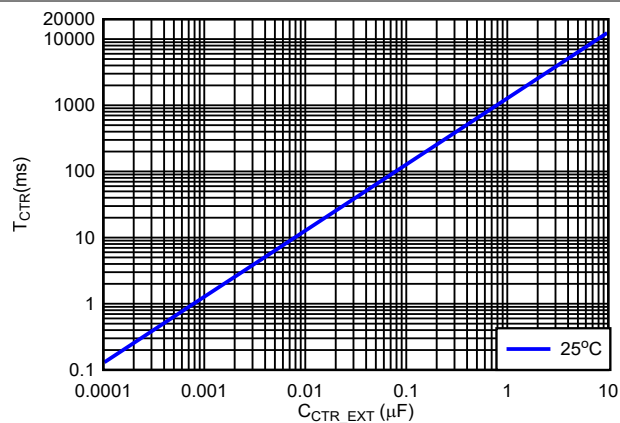
8 Detailed Description

8.1 Overview

The TPS38 is a family of high voltage and low quiescent current reset IC with fixed threshold voltage. Voltage divider is integrated to eliminate the need for external resistors and eliminate leakage current that comes with resistor dividers. However, it can also support external resistor if required by application, the lowest threshold 800 mV (bypass internal resistor ladder) is recommended for external resistors use case to take advantage of faster detection time and lower I_{SENSE} current.

VDD, SENSE and RESET pins can support 65 V continuous operation; both VDD and SENSE voltage levels can be independent of each other, meaning VDD pin can be connected at 2.7 V while SENSE pins are connected to a higher voltage. One thing of note, the TPS38 does not have clamps within the device so external circuits or devices must be added to limit the voltages to the absolute max limit.

Additional features include programmable sense time delay (CTS1, CTS2) and reset delay time and manual reset (CTR1 / $\overline{MR}$, CTR2 / $\overline{MR}$).

8.2 Functional Block Diagram
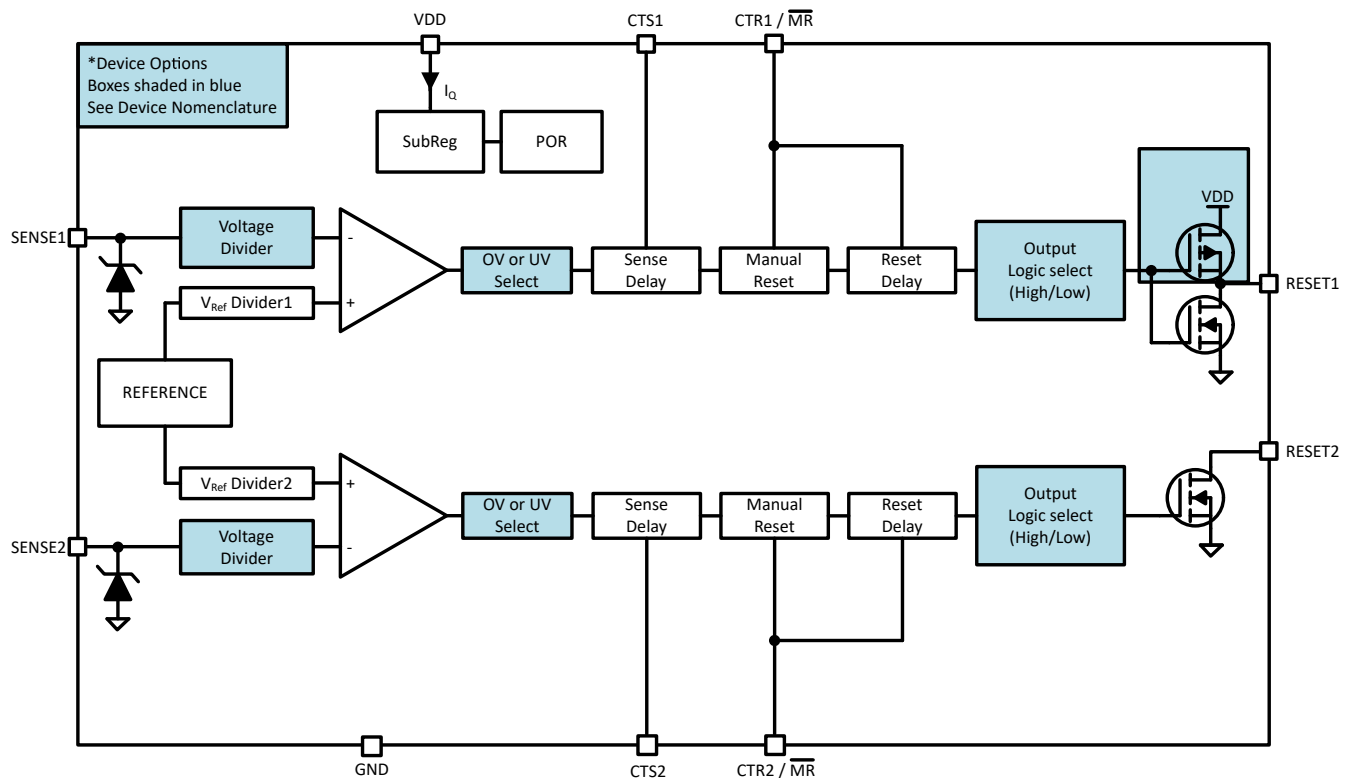
図 8-1. Functional Block Diagram

Refer to セクション 5 for complete list of topologies and output logic combinations.

8.3 Feature Description

8.3.1 Input Voltage (VDD)

VDD operating voltage ranges from 2.7 V to 65 V. An input supply capacitor is not required for this device; however, if the input supply is noisy good analog practice is to place a 0.1 µF capacitor between the VDD and GND.

VDD needs to be at or above $V_{DD(MIN)}$ for at least the start-up time delay (t_{SD}) for the device to be fully functional.

VDD voltage is independent of V_{SENSE} and V_{RESET}, meaning that VDD can be higher or lower than the other pins.

8.3.1.1 Undervoltage Lockout ($V_{POR} < V_{DD} < UVLO$)

When the voltage on VDD is less than the UVLO voltage, but greater than the power-on reset voltage (V_{POR}), the output pins will be in reset, regardless of the voltage at SENSE pins.

8.3.1.2 Power-On Reset ($V_{DD} < V_{POR}$)

When the voltage on VDD is lower than the power on reset voltage (V_{POR}), the output signal is undefined and is not to be relied upon for proper device function.
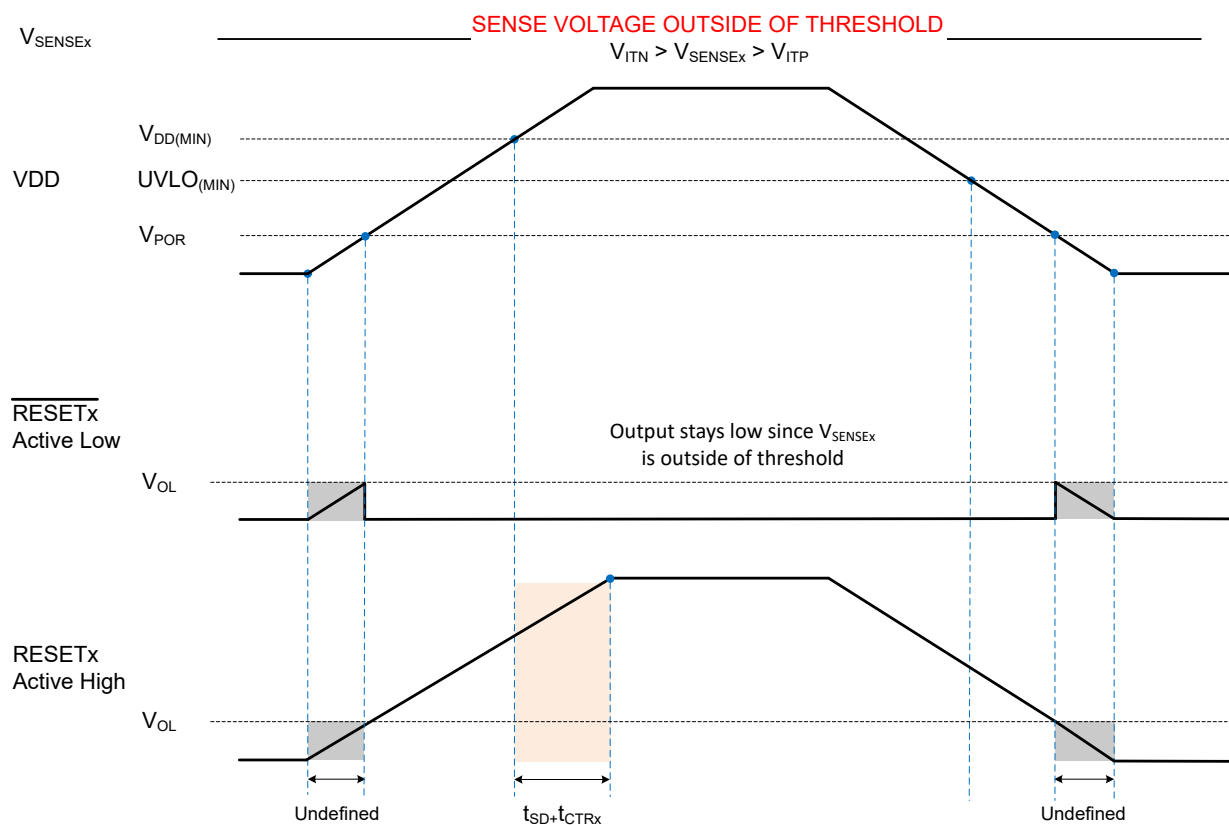
図 8-2. Power Cycle (SENSE Outside of Nominal Voltage)

図 8-2 assumes an external pull-up resistor is connected to the reset pin via VDD.

Product Folder Links: TPS38

English Data Sheet: SNVSBJ2
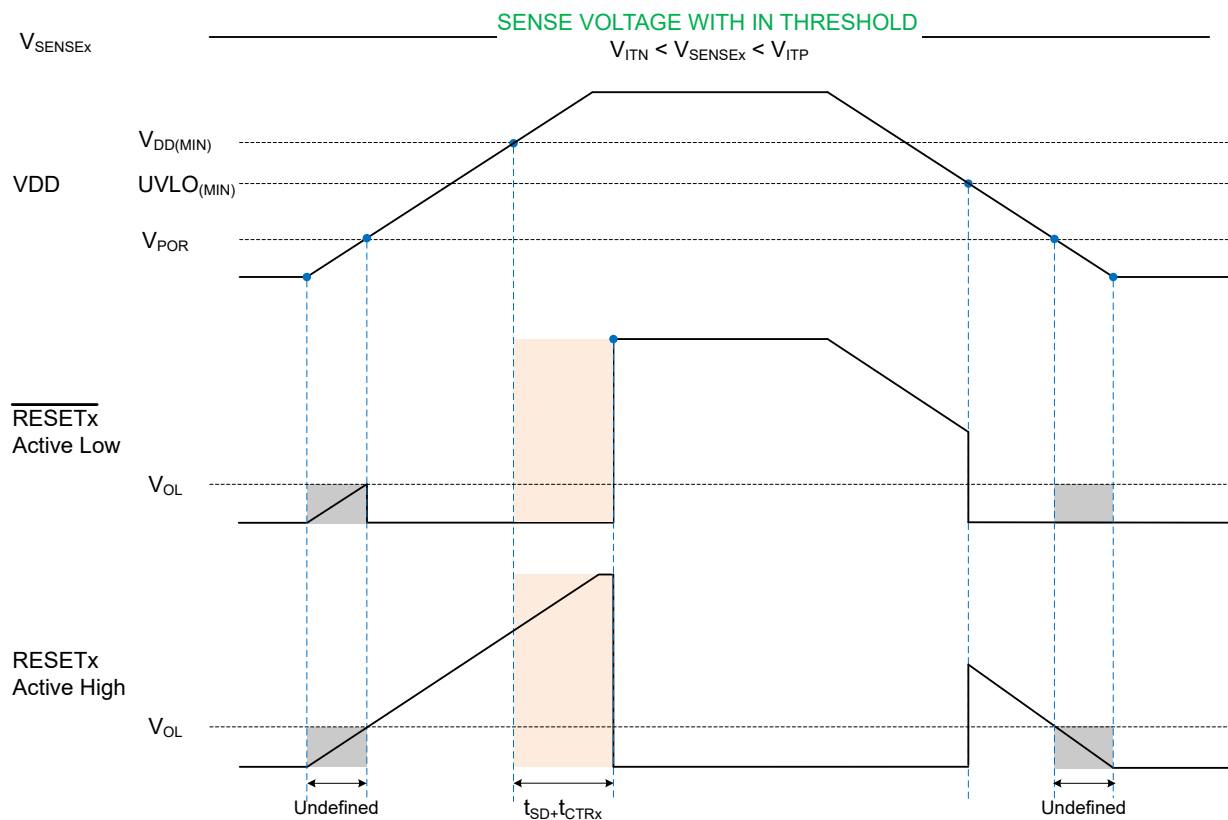
図 8-3. Power Cycle (SENSE Within Nominal Voltage)

図 8-3 assumes an external pull-up resistor is connected to the reset pin via VDD.

Product Folder Links: *TPS38*

English Data Sheet: *SNVSBJ2*

8.3.2 SENSE

The TPS38 high voltage family integrates two voltage comparators, a precision reference voltage and trimmed resistor divider. This configuration optimizes device accuracy because all resistor tolerances are accounted for in the accuracy and performance specifications. Device also has built-in hysteresis that provides noise immunity and ensures stable operation.

Channels are independent of each other, meaning that SENSE1 and SENSE2 and respective outputs can be connected to different voltage rails.

Although not required in most cases, for noisy applications good analog design practice is to place a 1 nF to 10 nF bypass capacitor at the SENSEx inputs in order to reduce sensitivity to transient voltages on the monitored signal. SENSE1 and SENSE2 pins can be connected directly to VDD pin.

8.3.2.1 SENSE Hysteresis

The TPS38 has built-in hysteresis to avoid erroneous output reset release. The hysteresis is opposite to the threshold voltage; for overvoltage options the hysteresis is subtracted from the positive threshold (V_{ITP}), for undervoltage options hysteresis is added to the negative threshold (V_{ITN}).

図 8-4. Hysteresis (Overvoltage Active-Low)

図 8-5. Hysteresis (Overvoltage Active-High)

図 8-6. Hysteresis (Undervoltage Active-High)

図 8-7. Hysteresis (Undervoltage Active-Low)
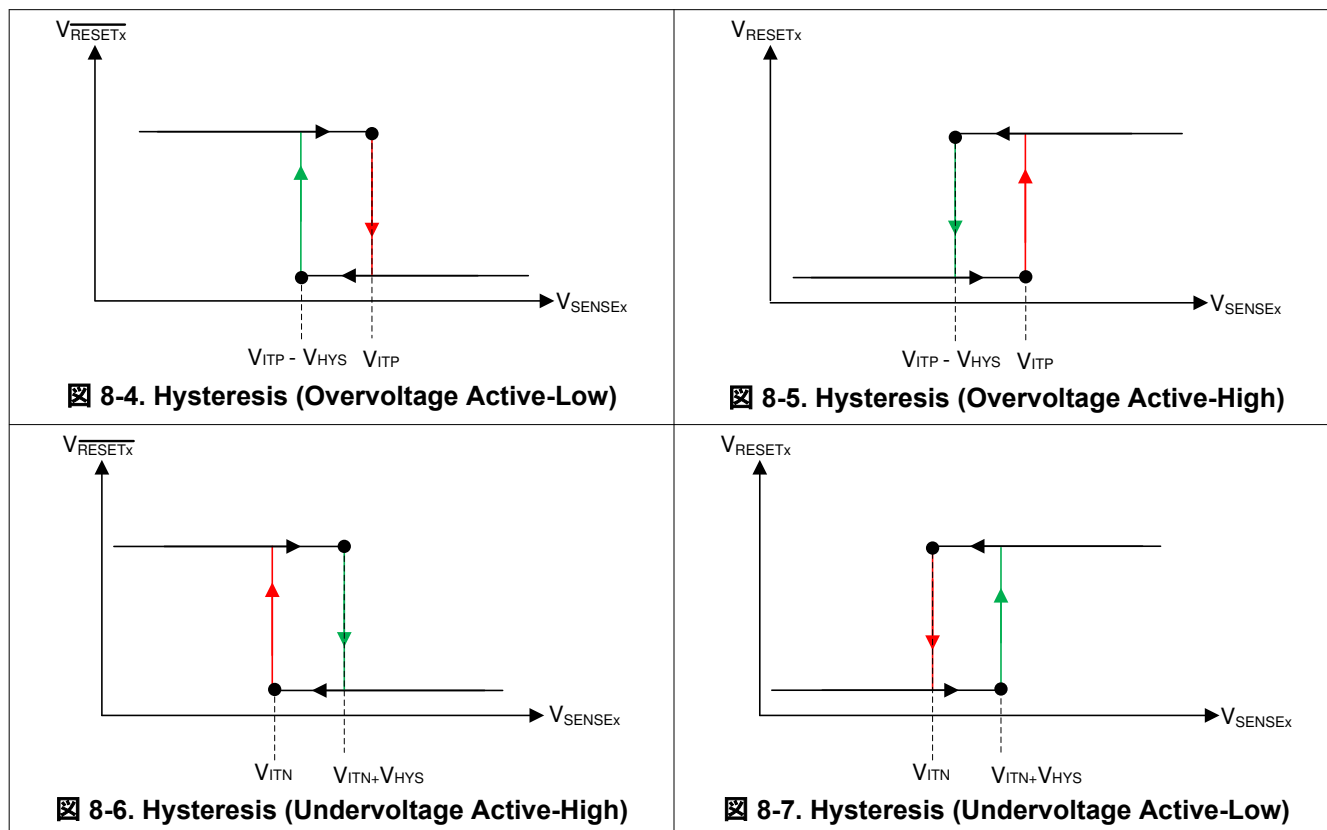
表 8-1. Common Hysteresis Lookup Table

TARGET			DEVICE ACTUAL HYSTERESIS OPTION
DETECT THRESHOLD	**TOPOLOGY**	**RELEASE VOLTAGE (V)**	
18.0 V	Overvoltage	17.5 V	-3%
18.0 V	Overvoltage	16.0 V	-11%
17.0 V	Overvoltage	16.5 V	-3%
16.0 V	Overvoltage	15.0 V	-6%
15.0 V	Overvoltage	14.0 V	-7%
6.0 V	Undervoltage	6.5 V	0.5 V
5.5 V	Undervoltage	6 V	0.5 V
8 V	Undervoltage	9 V	1 V
5 V	Undervoltage	7.5 V	2.5 V

表 8-1 shows a sample of hysteresis and voltage options for the TPS38. For threshold voltages ranging from 2.7 V to 8 V, one option is to select a fixed hysteresis value ranging from 0.5 V to 2.5 V in increments of 0.5 V. Additionally, a second option can be selected where the hysteresis value is a percentage of the threshold voltage. The percentage of voltage hysteresis ranges from 2% to 13%.

Knowing the amount of hysteresis voltage, the release voltage for the undervoltage (UV) channel is ($V_{ITN(UV)}$ + V_{HYS}) and for the overvoltage (OV) channel is ($V_{ITP(OV)}$ - V_{HYS}). For a visual understanding of the UV and OV release voltage, see 図 7-2 and 図 7-3 . The accuracy of the release voltage, or stated in the セクション 7.5 as *Hysteresis Accuracy* is ±1.5%. Expanding what is shown in 表 8-1, below are a few voltage hysteresis examples that include the hysteresis accuracy:

Undervoltage (UV) Channel

V_{ITN} = 0.8 V

Voltage Hysteresis (V_{HYS}) = 5% = 40 mV

Hysteresis Accuracy = ±1.5% = 39.4 mV or 40.6 mV

Release Voltage = V_{ITN} + V_{HYS} = 839.4 mV to 840.6 mV

Overvoltage (OV) Channel

V_{ITP} = 8 V

Voltage Hysteresis (V_{HYS}) = 2 V

Hysteresis Accuracy = ±1.5% = 1.97 V or 2.03 V

Release Voltage = V_{ITP} − V_{HYS} = 5.97 V to 6.03V

8.3.3 Output Logic Configurations

TPS38 has two channels with separate sense pins and reset pins that can be configured independently of each other. Channel 1 is available as Open-Drain and Push-Pull while channel 2 is only available as Open-Drain topology.

The available output logic configuration combinations are shown in Table 表 8-2.

表 8-2. TPS38 Output Logic

DESCRIPTION	NOMENCLATURE	VALUE	
GPN	TPS38 (+ topology)	CHANNEL 1	CHANNEL 2
Topology (OV and UV only) both channels are either OV or UV • UV = Undervoltage • OV = Overvoltage • PP = Push-Pull • OD = Open-Drain • L = Active low • H = Active high	TPS38A	UV OD L	UV OD L
	TPS38B	UV PP L	UV OD L
	TPS38D	UV PP L	UV OD H
	TPS38E	UV PP H	UV OD H
	TPS38F	UV PP H	UV OD L
	TPS38G	UV OD H	UV OD H
	TPS38H	UV OD H	UV OD L
	TPS38J	OV OD L	OV OD L
	TPS38M	OV PP L	OV OD L
	TPS38N	OV PP L	OV OD H
	TPS38O	OV PP H	OV OD H
	TPS38P	OV PP H	OV OD L

8.3.3.1 Open-Drain

Open-drain output requires an external pull-up resistor to hold the voltage high to the required voltage logic. Connect the pull-up resistor to the proper voltage rail to enable the output to be connected to other devices at the correct interface voltage levels.

To select the right pull-up resistor consider system V_{OH} and the (I_{lkg}) current provided in the electrical characteristics, high resistors values will have a higher voltage drop affecting the output voltage high. The open-drain output can be connected as a wired-AND logic with other open-drain signals such as another TPS38 open-drain output pin.

8.3.3.2 Push-Pull

Push-Pull output does not require an external resistor since is the output is internally pulled-up to VDD during V_{OH} condition and output will be connected to GND during V_{OH} condition.

8.3.3.3 Active-High (RESET)

RESET (active-high), denoted with no bar above the pin label. RESET remains low (V_{OL}, deasserted) as long as sense voltage is in normal operation within the threshold boundaries and VDD voltage is above UVLO. To assert a reset sense pins needs to meet the condition below:

• For undervoltage variant the SENSE voltage need to cross the lower boundary (V_{ITN}).
• For overvoltage variant the SENSE voltage needs to cross the upper boundary (V_{ITP}).

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8.3.3.4 Active-Low ($\overline{RESET}$)

$\overline{RESET}$ (active low) denoted with a bar above the pin label. $\overline{RESET}$ remains high voltage (V_{OH}, deasserted) (open drain variant V_{OH} is measured against the pullup voltage) as long as sense voltage is in normal operation within the threshold boundaries and VDD voltage is above UVLO. To assert a reset sense pins needs to meet the condition below:

- For undervoltage variant the SENSE voltage need to cross the lower boundary (V_{ITN}).
- For overvoltage variant the SENSE voltage needs to cross the upper boundary (V_{ITP}).

8.3.4 User-Programmable Reset Time Delay

The TPS38 has an adjustable reset release time delay with external capacitors. Channel timing is independent of each other.

- A capacitor in CTR1 / $\overline{MR}$ program the reset time delay of Output 1.
- A capacitor in CTR2 / $\overline{MR}$ program the reset time delay of Output 2.
- No capacitor on these pins gives the fastest reset delay time indicated in the セクション 7.6.

8.3.4.1 Reset Time Delay Configuration

The time delay (t_{CTR}) can be programmed by connecting a capacitor between CTR1 pin and GND, CTR2 for channel 2. In this section CTRx represent either channel 1 or channel 2.

The relationship between external capacitor $C_{CTRx\_EXT\ (typ)}$ and the time delay $t_{CTRx\ (typ)}$ is given by 式 1.

$$t_{CTRx\ (typ)} = -\ln(0.28) \times R_{CTRx\ (typ)} \times C_{CTRx\_EXT\ (typ)} + t_{CTRx\ (no\ cap)} \tag{1}$$

$R_{CTRx\ (typ)}$ = is in kilo ohms (kOhms)

$C_{CTRx\_EXT\ (typ)}$ = is given in microfarads (μF)

$t_{CTRx\ (typ)}$ = is the reset time delay in (ms)

The reset delay varies according to three variables: the external capacitor (C_{CTRx_EXT}), CTR pin internal resistance (R_{CTRx}) provided in セクション 7.5, and a constant. The minimum and maximum variance due to the constant is show in 式 2 and 式 3:

$$t_{CTRx\ (min)} = -\ln(0.31) \times R_{CTRx\ (min)} \times C_{CTRx\_EXT\ (min)} + t_{CTRx\ (no\ cap\ (min))} \tag{2}$$

$$t_{CTRx\ (max)} = -\ln(0.25) \times R_{CTRx\ (max)} \times C_{CTRx\_EXT\ (max)} + t_{CTRx\ (no\ cap\ (max))} \tag{3}$$

The recommended maximum reset delay capacitor for the TPS38 is limited to 10 μF as this ensures enough time for the capacitor to fully discharge when a voltage fault occurs. Also, having a too large of a capacitor value can cause very slow charge up (rise times) and system noise can cause the the internal circuit to trip earlier or later near the threshold. This leads to variation in time delay where it can make the delay accuracy worse in the presence of system noise.

When a voltage fault occurs, the previously charged up capacitor discharges and if the monitored voltage returns from the fault condition before the delay capacitor discharges completely, the delay will be shorter than expected. The capacitor will begin charging from a voltage above zero and resulting in shorter than expected time delay. A larger delay capacitor can be used so long as the capacitor has enough time to fully discharge during the duration of the voltage fault. To ensure the capacitor is fully discharged, the time period or duration of the voltage fault needs to be greater than 5% of the programmed reset time delay.

8.3.5 User-Programmable Sense Delay

TPS38 has adjustable sense release time delay with external capacitors. Channel timing are independent of each other. Sense delay is used as a de-glitcher or ignoring known transients.

- A capacitor in CTS1 program the excursion detection on SENSE1.
- A capacitor in CTS2 program the excursion detection on SENSE2.
- No capacitor on these pins gives the fastest detection time indicated in the セクション 7.6.

8.3.5.1 Sense Time Delay Configuration

The time delay (t_{CTS}) can be programmed by connecting a capacitor between CTS1 pin and GND, CTS2 for channel 2. In this section CTSx represent either channel 1 or channel 2.

The relationship between external capacitor $C_{CTSx\_EXT\ (typ)}$ and the time delay $t_{CTSx\ (typ)}$ is given by 式 4.

$$t_{CTSx\ (typ)} = -\ln(0.28) \times R_{CTSx\ (typ)} \times C_{CTSx\_EXT\ (typ)} + t_{CTSx\ (no\ cap)} \qquad (4)$$

R_{CTSx} = is in kilo ohms (kOhms)

C_{CTSX_EXT} = is given in microfarads (µF)

t_{CTSx} = is the sense time delay (ms)

The sense delay varies according to three variables: the external capacitor (C_{CTSx_EXT}), CTS pin internal resistance (R_{CTSx}) provided in セクション 7.5, and a constant. The minimum and maximum variance due to the constant is show in 式 5 and 式 6:

$$t_{CTSx\ (min)} = -\ln(0.31) \times R_{CTSx\ (min)} \times C_{CTSx\_EXT\ (min)} + t_{CTSx\ (no\ cap\ (min))} \qquad (5)$$

$$t_{CTSx\ (max)} = -\ln(0.25) \times R_{CTSx\ (max)} \times C_{CTSx\_EXT\ (max)} + t_{CTSx\ (no\ cap\ (max))} \qquad (6)$$

The recommended maximum sense delay capacitor for the TPS38 is limited to 10 µF as this ensures enough time for the capacitor to fully discharge when a voltage fault occurs. Also, having a too large of a capacitor value can cause very slow charge up (rise times) and system noise can cause the the internal circuit to trip earlier or later near the threshold. This leads to variation in time delay where it can make the delay accuracy worse in the presence of system noise.

When a voltage fault occurs, the previously charged up capacitor discharges and if the monitored voltage returns from the fault condition before the delay capacitor discharges completely, the delay will be shorter than expected. The capacitor will begin charging from a voltage above zero and resulting in shorter than expected time delay. A larger delay capacitor can be used so long as the capacitor has enough time between fault events to fully discharge during the duration of the voltage fault. To ensure the capacitor is fully discharged, the time period or time duration between fault events needs to be greater than 10% of the programmed sense time delay.

Product Folder Links: *TPS38*

English Data Sheet: SNVSBJ2

8.3.6 Manual RESET (CTR1 / $\overline{MR}$) and (CTR2 / $\overline{MR}$) Input

The manual reset input allows a processor or other logic circuits to initiate a reset. In this section $\overline{MR}$ is a generic reference to (CTR1 / $\overline{MR}$) and (CTR2 / $\overline{MR}$). A logic low on $\overline{MR}$ causes $\overline{RESET1}$ to assert on reset output. After $\overline{MR}$ is left floating, $\overline{RESET1}$ will release the reset if the voltage at SENSE1 pin is at nominal voltage. $\overline{MR}$ should not be driven high, this pin should be left floating or connected to a capacitor to GND, this pin can be left unconnected if is not used.

If the logic driving the $\overline{MR}$ cannot tri-state (floating and GND) then a logic-level FET should be used as illustrated in 図 8-8.
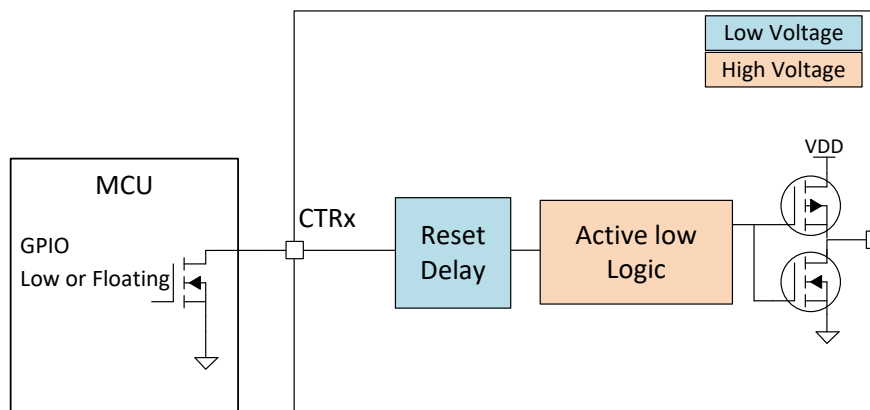
図 8-8. Manual Reset Implementation

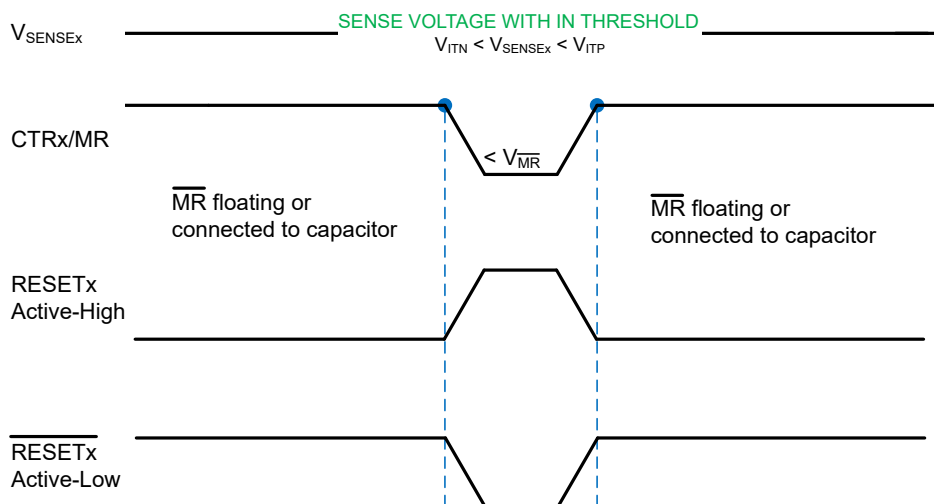**図 8-9. Manual Rest Timing Diagram**

表 8-3. $\overline{MR}$ Functional Table

$\overline{MR}$	SENSE ON NOMINAL VOLTAGE	RESET STATUS
Low	Yes	Reset asserted
Floating	Yes	Fast reset release when SENSE voltage goes back to nominal voltage
Capacitor	Yes	Programmable reset time delay
High	Yes	NOT Recommended

8.3.7 Adjustable Voltage Thresholds

式 7 illustrates an example of how to adjust the voltage threshold with external resistor dividers. The resistors can be calculated depending on the desired voltage threshold and device part number. TI recommends using the 0.8 V voltage threshold device when using an adjustable voltage variant. This variant bypasses the internal resistor ladder.

For example, consider a 12 V rail being monitored V_{MON} for undervoltage (UV) using channel 1 of the TPS38A010122DSKR variant. Using 式 7 and shown in 図 8-10, R_1 is the top resistor of the resistor divider that is between V_{MON} and V_{SENSE2}, R_2 is the bottom resistor that is between V_{SENSE2} and GND, V_{MON} is the voltage rail that is being monitored and V_{SENSE2} is the input threshold voltage. The monitored UV threshold, denoted as V_{MON-}, where the device will assert a reset signal occurs when $V_{SENSE2} = V_{IT-(UV)}$ or, for this example, V_{MON-} = 10.8V which is 90% from 12 V. Using 式 7 and assuming R_2 = 10kΩ, R_1 can be calculated shown in 式 8 where I_{R1} is represented in 式 9:

$$V_{SENSE2} = V_{MON-} \times (R_2 \div (R_1 + R_2)) \qquad (7)$$

$$R_1 = (V_{MON-} - V_{SENSE2}) \div I_{R1} \qquad (8)$$

$$I_{R1} = I_{R2} = V_{SENSE2} \div R_2 \qquad (9)$$

Substituting 式 9 into 式 8 and solving for R_1 in 式 7, R_1 = 125kΩ. The TPS38A010122DSKR is typically meant to monitor a 0.8 V rail with ±2% voltage threshold hysteresis. For the reset signal to become deasserted, V_{MON} would need to go above $V_{IT-} + V_{HYS}$. For this example,
V_{MON} = 11.016 V when the reset signal becomes deasserted.

There are inaccuracies that must be taken into consideration while adjusting voltage thresholds. Aside from the tolerance of the resistor divider, there is an internal resistance of the SENSE pin that may affect the accuracy of the resistor divider. Although expected to be very high impedance, users are recommended to calculate the values for the design specifications. The internal SENSE resistance R_{SENSE} can be calculated by the SENSE voltage V_{SENSE} divided by the SENSE current I_{SENSE} as shown in 式 11. V_{SENSE} can be calculated using 式 7 depending on the resistor divider and monitored voltage. I_{SENSE} can be calculated using 式 10.

$$I_{SENSE} = [(V_{MON} - V_{SENSE}) \div R_1] - (V_{SENSE} \div R_2) \qquad (10)$$

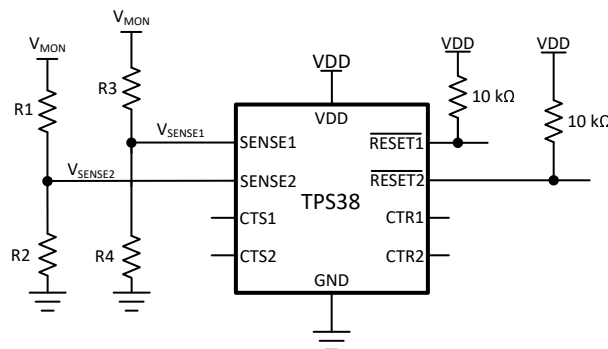$$R_{SENSE} = V_{SENSE} \div I_{SENSE} \qquad (11)$$

図 8-10. Adjustable Voltage Threshold with External Resistor Dividers

Product Folder Links: *TPS38*
English Data Sheet: SNVSBJ2

8.4 Device Functional Modes

表 8-4. Undervoltage Detect Functional Mode Truth Table

DESCRIPTION	SENSE		CTR [1] / $\overline{MR}$ PIN	VDD PIN	OUTPUT [2] (RESET PIN)
	PREVIOUS CONDITION	CURRENT CONDITION			
Normal Operation	SENSE > $V_{ITN(UV)}$	SENSE > $V_{ITN(UV)}$	Open or capacitor connected	V_{DD} > $V_{DD(MIN)}$	High
Undervoltage Detection	SENSE > $V_{ITN(UV)}$	SENSE < $V_{ITN(UV)}$	Open or capacitor connected	V_{DD} > $V_{DD(MIN)}$	Low
Undervoltage Detection	SENSE < $V_{ITN(UV)}$	SENSE > $V_{ITN(UV)}$	Open or capacitor connected	V_{DD} > $V_{DD(MIN)}$	Low
Normal Operation	SENSE < $V_{ITN(UV)}$	SENSE > $V_{ITN(UV)}$ + HYS	Open or capacitor connected	V_{DD} > $V_{DD(MIN)}$	High
Manual Reset	SENSE > $V_{ITN(UV)}$	SENSE > $V_{ITN(UV)}$	Low	V_{DD} > $V_{DD(MIN)}$	Low
UVLO Engaged	SENSE > $V_{ITN(UV)}$	SENSE > $V_{ITN(UV)}$	Open or capacitor connected	V_{POR} < V_{DD} < $V_{DD(MIN)}$	Low
Below V_{POR}, Undefined Output	SENSE > $V_{ITN(UV)}$	SENSE > $V_{ITN(UV)}$	Open or capacitor connected	V_{DD} < V_{POR}	Undefined

(1)   Reset time delay is ignored in the truth table
(2)   Open-drain active low output. External pull-up resistor to high voltage

表 8-5. Overvoltage Detect Functional Mode Truth Table

DESCRIPTION	SENSE		CTR [1] / $\overline{MR}$ PIN	VDD PIN	OUTPUT [2] (RESET PIN)
	PREVIOUS CONDITION	CURRENT CONDITION			
Normal Operation	SENSE < $V_{ITN(OV)}$	SENSE < $V_{ITN(OV)}$	Open or capacitor connected	V_{DD} > $V_{DD(MIN)}$	High
Overvoltage Detection	SENSE < $V_{ITN(OV)}$	SENSE > $V_{ITN(OV)}$	Open or capacitor connected	V_{DD} > $V_{DD(MIN)}$	Low
Overvoltage Detection	SENSE > $V_{ITN(OV)}$	SENSE < $V_{ITN(OV)}$	Open or capacitor connected	V_{DD} > $V_{DD(MIN)}$	Low
Normal Operation	SENSE > $V_{ITN(OV)}$	SENSE < $V_{ITN(OV)}$ - HYS	Open or capacitor connected	V_{DD} > $V_{DD(MIN)}$	High
Manual Reset	SENSE < $V_{ITN(OV)}$	SENSE < $V_{ITN(OV)}$	Low	V_{DD} > $V_{DD(MIN)}$	Low
UVLO Engaged	SENSE < $V_{ITN(OV)}$	SENSE < $V_{ITN(OV)}$	Open or capacitor connected	V_{POR} < V_{DD} < UVLO	Low
Below V_{POR}, Undefined Output	SENSE < $V_{ITN(OV)}$	SENSE < $V_{ITN(OV)}$	Open or capacitor connected	V_{DD} < V_{POR}	Undefined

(1)   Reset time delay is ignored in the truth table
(2)   Open-drain active low output. External pull-up resistor to high voltage

# 9 Application and Implementation

9.1 Application Information

The following sections describe in detail how to properly use this device, depending on the requirements of the final application.

9.2 Typical Application

9.2.1 High Voltage – Fast AC Signal Monitoring For Power Fault Detection

In many industrial and factory automation applications, there are multiple power rails that power various subsystems within the application. Some of these power rails include 24 / 48 VAC AC sources with a known operating frequency that requires a full-bridge rectifier and capacitors to convert its signal to a DC voltage where it can be monitored by a voltage supervisor. One drawback with the described conversion is the response time of the DC voltage when the AC power rail experiences a change of operating frequency or voltage amplitude. Due to the output filter of the full-bridge rectifier, the detection in the change of voltage or operating frequency may require several AC cycles before the voltage supervisor outputs a fault condition. The direct monitoring of the AC source by using a "Resistive-Drop" supply topology circuit provides the user a fast transient fault detection. In this design example, the TPS38 adjustable version is being highlighted with the ability to offer a unique solution by monitoring the output of the AC source for undervoltage operation.
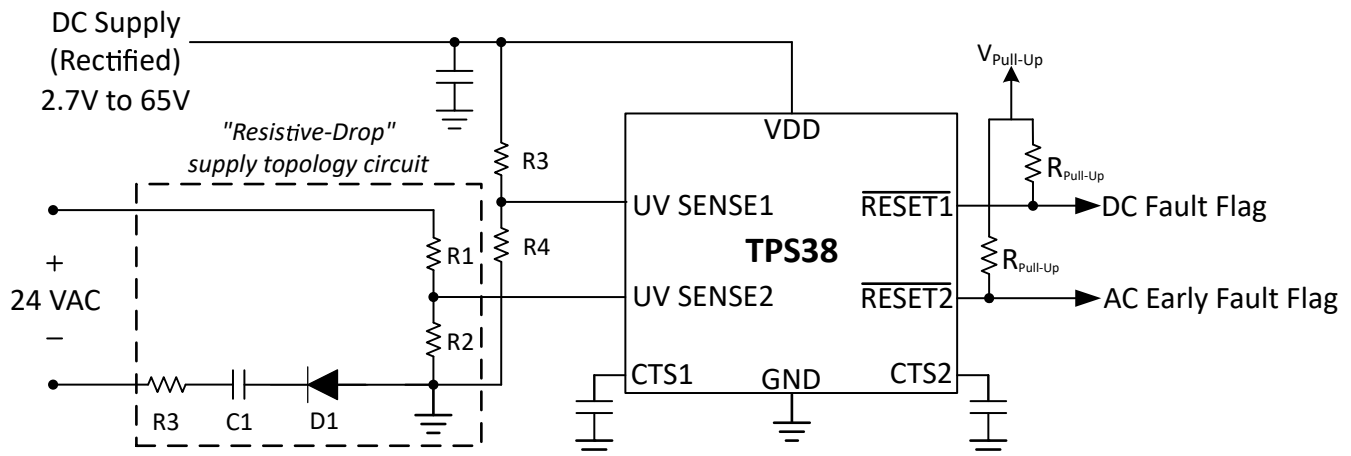
* The circuit solution is not isolated and one must take into account when planning to use in high power systems.

図 9-1. Sensing an AC Signal for Power Fault Detection

9.2.1.1 Design Requirements

This design requires voltage supervision on an AC, with a known operating frequency, power supply rail. The undervoltage fault sensing is achieved by monitoring the DC output of a full bridge rectifier while the undervoltage fault is detected by inputting a half wave signal and its voltage frequency and magnitude are being monitored. The target output of this TPS38 application is for 5V reset logic.

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PARAMETER	DESIGN REQUIREMENT	DESIGN RESULT
Power rail voltage Supervision	Monitor 24 VAC 800 Hz power supply for undervoltage conditions. Trigger undervoltage fault at 5 V and at 25.5 V.	TPS38 provides voltage monitoring with 1.5% max accuracy with adjustable/non-adjustable variations.
Maximum input voltage	Operate with power supply input up to 34 V.	The TPS38 can support a VDD of up to 65 V.
Output logic voltage	Open-Drain Output Topology	An open-drain output is recommended to provide the a 5 V reset signal.
SENSE1 delay when a fault is detected	$\overline{\text{RESET1}}$ delay of at least 1.28 ms	C_{CTS1} = 10 nF sets 1.28 ms delay
SENSE2 delay when a fault is detected	$\overline{\text{RESET2}}$ delay of at least 0.625 ms which is the time between half wave cycles	C_{CTS2} = 5.6 nF sets 717 µs delay
RESET1 delay when returning from a fault	$\overline{\text{RESET1}}$ delay of at least 12.8 ms	C_{CTR1} = 10 nF sets 12.8 ms delay
Voltage monitor accuracy	Maximum voltage monitor accuracy of 1.5%.	The TPS38 has 1.5% maximum voltage monitor accuracy.

9.2.1.2 Detailed Design Procedure

The main advantage of this unique application is being able to monitor a single AC source with a known operating frequency power rail. Because the TPS38 is a dual input undervoltage detector with delay function, detecting faults either from a change of operating frequency range or voltage amplitude of the AC source is achievable.

図 9-1 illustrates an example of how the TPS38 is monitoring an AC source. Input to SENSE1 of TPS38 is monitoring a full wave rectifier DC signal. The DC signal is the result from the rectification of the 24 VAC source and monitors the AC source for undervoltage events due to a change of voltage amplitude or a decrease to operating frequency. Input to SENSE2 of TPS38 will monitor the AC source by using a "resistive-drop" supply topology circuit. The unique circuit resistively divides the AC voltage signal and provides only the positive half wave 図 9-2 into SENSE2 input. The half wave signal does not go through any output filter and hence any change to the AC voltage or operating frequency can be rapidly detected. Knowing the operating frequency of the AC source and converting to the time domain, the TPS38 SENSE2 delay can be programmed, by the capacitor on CTS2 pin, to equal or be greater than one-half of the operating period (the frequency of the half wave rectification signal) or the half cycle shown in 図 9-2. When the half wave voltage amplitude falls below the SENSE2 threshold voltage, the SENSE2 time delay counter begins to increment. If the next half wave voltage amplitude exceeds the SENSE2 threshold voltage, the SENSE2 time delay counter will reset and the TPS38 $\overline{\text{RESET2}}$ pin will indicate no fault was detected. Conversely, if the voltage amplitude of the half wave does not reach the SENSE2 threshold voltage within the programmed time delay of t_{CTS}, a fault will occur. Also, a fault can occur if the operating frequency from the AC source decreases, resulting in lower AC voltage amplitude at the programmed time delay t_{CTS}.
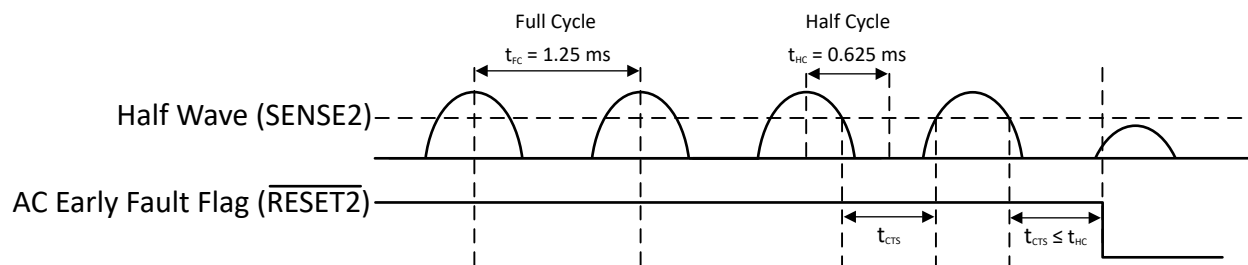
Product Folder Links: *TPS38*

English Data Sheet: *SNVSBJ2*

図 9-2. Design 2 Timing Diagram

The TPS38, with its ability of having a wide VDD range from 2.7V to 65V and dual input undervoltage detection, offers a unique AC power rail monitoring solution. Combining SENSE delay feature with the "resistive-drop" supply circuitry, detecting an undervoltage event on the half cycle of the AC power rail provides a fast power fault response. Also, the TPS38 provides an undervoltage monitoring and SENSE delay fault detection for the same AC power rail. With undervoltage supervision of the AC power rail, applications needing a specific operating DC range to protect its subsystems is achieve through TPS38. Good design practice recommends using a 0.1-µF capacitor on the VDD pin and this capacitance may need to increase if using an adjustable version with a resistor divider.

Note that this design solution is not isolated and one must take into account when planning to use in high power systems.

SENSE1 is configured to monitor UV on the DC rail. The CTS1 and CTR1 capacitor can be used to set different timing thresholds for fault trigger and fault recovery. 図 9-3 and 図 9-4 show the behavior of RESET1 based on the voltage on SENSE1.

Product Folder Links: *TPS38*

English Data Sheet: *SNVSBJ2*

9.2.1.3 Application Curves
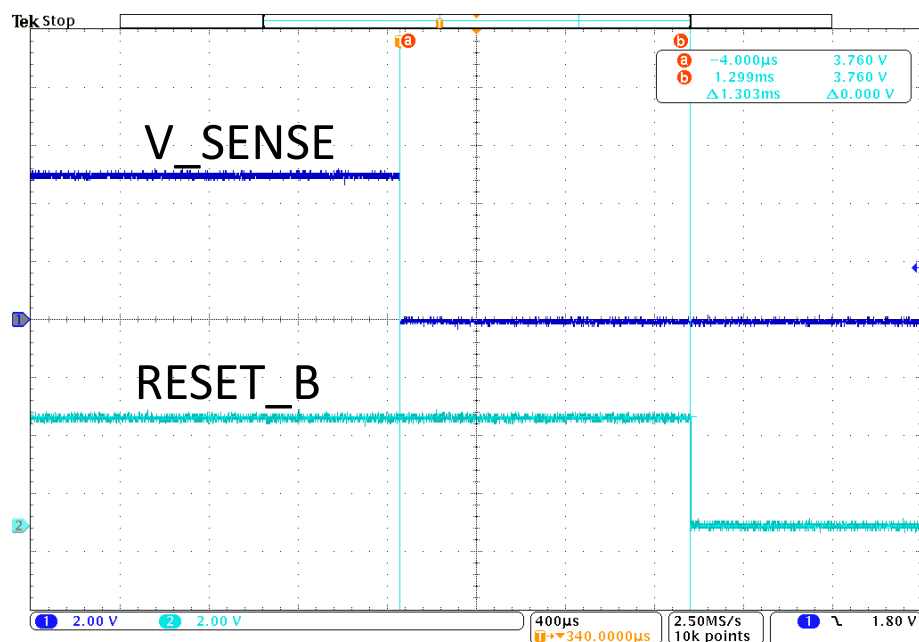
図 9-3. Undervoltage Reset Waveform
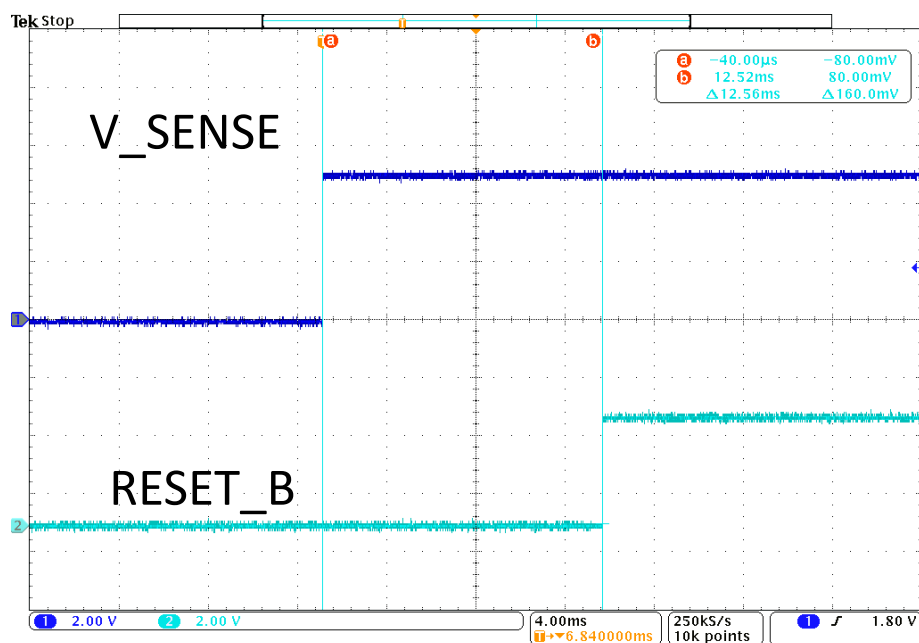
図 9-4. Undervoltage Recovery Waveform

9.3 Power Supply Recommendations

These devices are designed to operate from an input supply with a voltage range between 1.4 V (V_{POR}) to 65 V (maximum operation). Good analog design practice recommends placing a minimum 0.1 µF ceramic capacitor as near as possible to the VDD pin.

9.3.1 Power Dissipation and Device Operation

The permissible power dissipation for any package is a measure of the capability of the device to pass heat from the power source, the junctions of the IC, to the ultimate heat sink, the ambient environment. Thus, the power dissipation is dependent on the ambient temperature and the thermal resistance across the various interfaces between the die junction and ambient air.

The maximum continuous allowable power dissipation for the device in a given package can be calculated using 式 12:

$$P_{D-MAX} = ((T_{J-MAX} – T_A) / R_{\theta JA}) \tag{12}$$

The actual power being dissipated in the device can be represented by 式 13:

$$P_D = V_{DD} \times I_{DD} + p_{RESET} \tag{13}$$

p_{RESET} is calculated by 式 14 or 式 15

$$p_{RESET\ (PUSHPULL)} = VDD - V_{RESET} \times I_{RESET} \tag{14}$$

$$p_{RESET\ (OPEN-DRAIN)} = V_{RESET} \times I_{RESET} \tag{15}$$

式 12 and 式 13 establish the relationship between the maximum power dissipation allowed due to thermal consideration, the voltage drop across the device, and the continuous current capability of the device. These two equations should be used to determine the optimum operating conditions for the device in the application.

In applications where lower power dissipation (P_D) and/or excellent package thermal resistance ($R_{\theta JA}$) is present, the maximum ambient temperature (T_{A-MAX}) may be increased.

In applications where high power dissipation and/or poor package thermal resistance is present, the maximum ambient temperature (T_{A-MAX}) may have to be de-rated. T_{A-MAX} is dependent on the maximum operating junction temperature ($T_{J-MAX-OP}$ = 125°C), the maximum allowable power dissipation in the device package in the application (P_{D-MAX}), and the junction-to ambient thermal resistance of the part/package in the application ($R_{\theta JA}$), as given by 式 16:

$$T_{A-MAX} = (T_{J-MAX-OP} – (R_{\theta JA} \times P_{D-MAX})) \tag{16}$$

9.4 Layout

9.4.1 Layout Guidelines

- Make sure that the connection to the VDD pin is low impedance. Good analog design practice is to place a greater than 0.1 μF ceramic capacitor as near as possible to the VDD pin.
- To further improve the noise immunity on the SENSEx pins, placing a 1 nF to 10 nF capacitor between the SENSEx pins and GND can reduce the sensitivity to transient voltages on the monitored signal.
- If a capacitor is used on CTS1, CTS2, CTR1, or CTR2, place these components as close as possible to the respective pins. If the capacitor adjustable pins are left unconnected, make sure to minimize the amount of parasitic capacitance on the pins to less than 5 pF.
- For open-drain variants, place the pull-up resistors on $\overline{\text{RESET1}}$ and $\overline{\text{RESET2}}$ pins as close to the pins as possible.
- When laying out metal traces, separate high voltage traces from low voltage traces as much as possible. If high and low voltage traces need to run close by, spacing between traces should be greater than 20 mils (0.5 mm).
- Do not have high voltage metal pads or traces closer than 20 mils (0.5 mm) to the low voltage metal pads or traces.

9.4.2 Layout Example

The DSK layout example in 図 9-5 shows how the TPS38 is laid out on a printed circuit board (PCB) with user-defined delays.
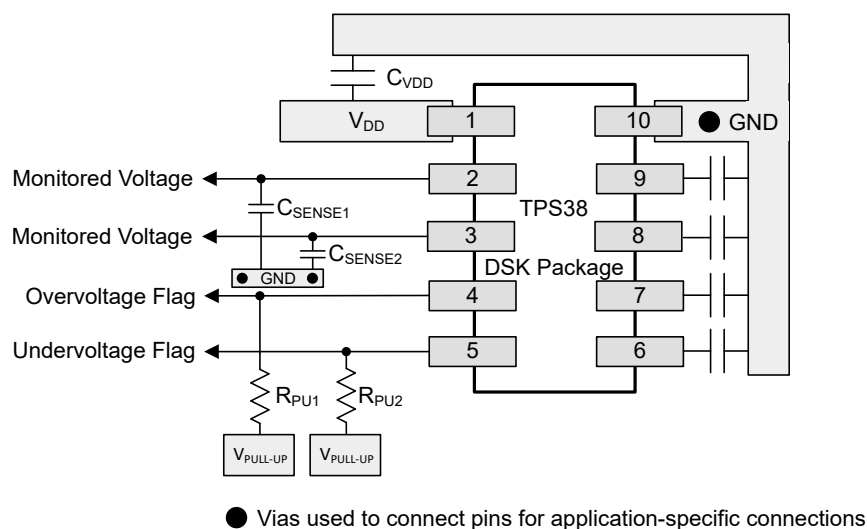

● Vias used to connect pins for application-specific connections

図 9-5. TPS38 DSK Package Recommended Layout

Product Folder Links: *TPS38*

English Data Sheet: SNVSBJ2

The DYY layout example in 図 9-6 shows how the TPS38 is laid out on a printed circuit board (PCB) with user-defined delays.

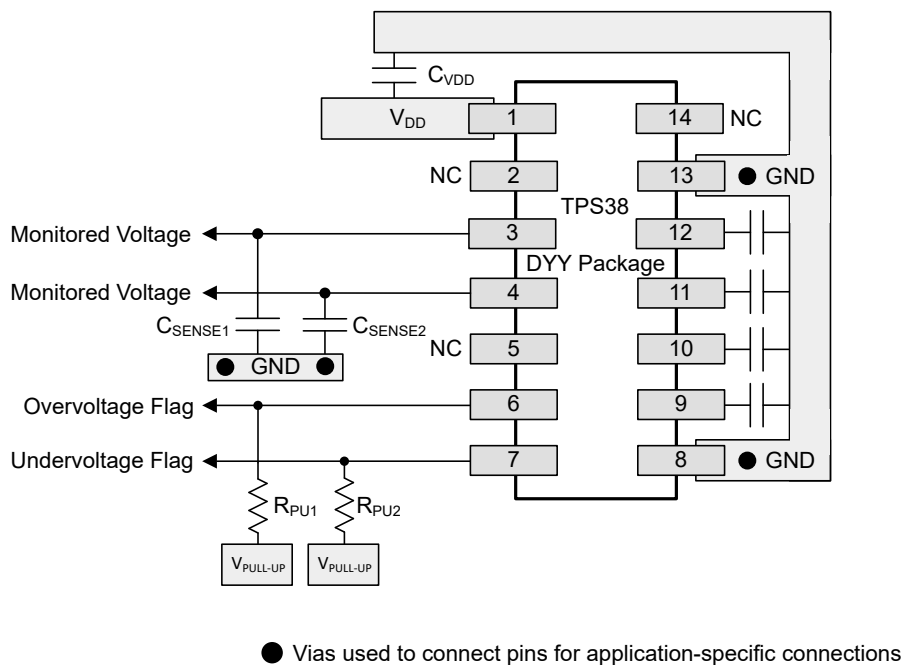● Vias used to connect pins for application-specific connections

図 9-6. TPS38 DYY Package Recommended Layout

9.4.3 Creepage Distance

Per IEC 60664 Creepage is the shortest distance between two conductive parts or as shown in 図 9-7 the distance between high voltage conductive parts and grounded parts, the floating conductive part is ignored and subtracted from the total distance.

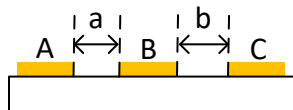**図 9-7. Creepage Distance**

図 9-7 details:

- A = Left pins (high voltage)
- B = Central pad (not internally connected, can be left floating or connected to GND)
- C = Right pins (low voltage)
- Creepage distance = a + b

Product Folder Links: *TPS38*

English Data Sheet: SNVSBJ2

10 Device and Documentation Support

10.1 Device Nomenclature

セクション 5 shows how to decode the function of the device based on its part number

表 10-1 shows TPS38 possible voltage options per channel. Contact TI sales representatives or on TI's E2E forum for details and availability of other options; minimum order quantities apply.

表 10-1. Voltage Options

100 mV STEPS				400 mV STEPS		500 mV STEPS		1 V STEPS	
NOMEN-CLATURE	VOLTAGE OPTIONS	NOMEN-CLATURE	VOLTAGE OPTIONS	NOMEN-CLATURE	VOLTAGE OPTIONS	NOMEN-CLATURE	VOLTAGE OPTIONS	NOMEN-CLATURE	VOLTAGE OPTIONS
01	800 mV (divider bypass)	70	7.0 V	A0	10.4 V	D0	20.5 V	F0	31.0 V
27	2.7 V	71	7.1 V	A1	10.8 V	D1	21.0 V	F1	32.0 V
28	2.8 V	72	7.2 V	A2	11.2 V	D2	21.5 V	F2	33.0 V
29	2.9 V	73	7.3 V	A3	11.6 V	D3	22.0 V	F3	34.0 V
30	3.0 V	74	7.4 V	A4	12.0 V	D4	22.5 V	F4	35.0 V
31	3.1 V	75	7.5 V	A5	12.4 V	D5	23.0 V	F5	36.0 V
32	3.2 V	76	7.6 V	A6	12.8 V	D6	23.5 V		
33	3.3 V	77	7.7 V	A7	13.2 V	D7	24.0 V		
34	3.4 V	78	7.8 V	A8	13.6 V	D8	24.5 V		
35	3.5 V	79	7.9 V	A9	14.0 V	D9	25.0 V		
36	3.6 V	80	8.0 V	B0	14.4 V	E0	25.5 V		
37	3.7 V	81	8.1 V	B1	14.8 V	E1	26.0 V		
38	3.8 V	82	8.2 V	B2	15.2 V	E2	26.5 V		
39	3.9 V	83	8.3 V	B3	15.6 V	E3	27.0 V		
40	4.0 V	84	8.4 V	B4	16.0 V	E4	27.5 V		
41	4.1 V	85	8.5 V	B5	16.4 V	E5	28.0 V		
42	4.2 V	86	8.6 V	B6	16.8 V	E6	28.5 V		
43	4.3 V	87	8.7 V	B7	17.2 V	E7	29.0 V		
44	4.4 V	88	8.8 V	B8	17.6 V	E8	29.5 V		
45	4.5 V	89	8.9 V	B9	18.0 V	E9	30.0 V		
46	4.6 V	90	9.0 V	C0	18.4 V				
47	4.7 V	91	9.1 V	C1	18.8 V				
48	4.8 V	92	9.2 V	C2	19.2 V				
49	4.9 V	93	9.3 V	C3	19.6 V				
50	5.0 V	94	9.4 V	C4	20.0 V				
51	5.1 V	95	9.5 V						
52	5.2 V	96	9.6 V						
53	5.3 V	97	9.7 V						
54	5.4 V	98	9.8 V						
55	5.5 V	99	9.9 V						
56	5.6 V	00	10.0 V						
57	5.7 V								
58	5.8 V								
59	5.9 V								
60	6.0 V								

Product Folder Links: *TPS38*

English Data Sheet: SNVSBJ2

表 10-1. Voltage Options (continued)

100 mV STEPS				400 mV STEPS		500 mV STEPS		1 V STEPS	
NOMEN-CLATURE	VOLTAGE OPTIONS	NOMEN-CLATURE	VOLTAGE OPTIONS	NOMEN-CLATURE	VOLTAGE OPTIONS	NOMEN-CLATURE	VOLTAGE OPTIONS	NOMEN-CLATURE	VOLTAGE OPTIONS
61	6.1 V								
62	6.2 V								
63	6.3 V								
64	6.4 V								
65	6.5 V								
66	6.6 V								
67	6.7 V								
68	6.8 V								
69	6.9 V								

10.2 ドキュメントの更新通知を受け取る方法

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10.3 サポート・リソース

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10.4 Trademarks

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10.5 静電気放電に関する注意事項

この IC は、ESD によって破損する可能性があります。テキサス・インスツルメンツは、IC を取り扱う際には常に適切な注意を払うことを推奨します。正しい取り扱いおよび設置手順に従わない場合、デバイスを破損するおそれがあります。

ESD による破損は、わずかな性能低下からデバイスの完全な故障まで多岐にわたります。精密な IC の場合、パラメータがわずかに変化するだけで公表されている仕様から外れる可能性があるため、破損が発生しやすくなっています。

10.6 用語集

テキサス・インスツルメンツ用語集　　　この用語集には、用語や略語の一覧および定義が記載されています。

PACKAGE OPTION ADDENDUM

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TPS38A752933DSKR	Active	Production	SON (DSK) | 10	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2Q3L
TPS38A752933DSKR.A	Active	Production	SON (DSK) | 10	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2Q3L
TPS38B752933DSKR	Active	Production	SON (DSK) | 10	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2Q4L
TPS38B752933DSKR.A	Active	Production	SON (DSK) | 10	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2Q4L

(1) Status: For more details on status, see our product life cycle.

(2) Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

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OTHER QUALIFIED VERSIONS OF TPS38 :

● Automotive : TPS38-Q1

NOTE: Qualified Version Definitions:

    ● Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

TAPE AND REEL INFORMATION

REEL DIMENSIONS

Reel Diameter

Reel Width (W1)

TAPE DIMENSIONS

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

Sprocket Holes

User Direction of Feed

Pocket Quadrants

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS38A752933DSKR	SON	DSK	10	3000	180.0	8.4	2.8	2.8	1.0	4.0	8.0	Q2
TPS38B752933DSKR	SON	DSK	10	3000	180.0	8.4	2.8	2.8	1.0	4.0	8.0	Q2

TAPE AND REEL BOX DIMENSIONS

*All dimensions are nominal

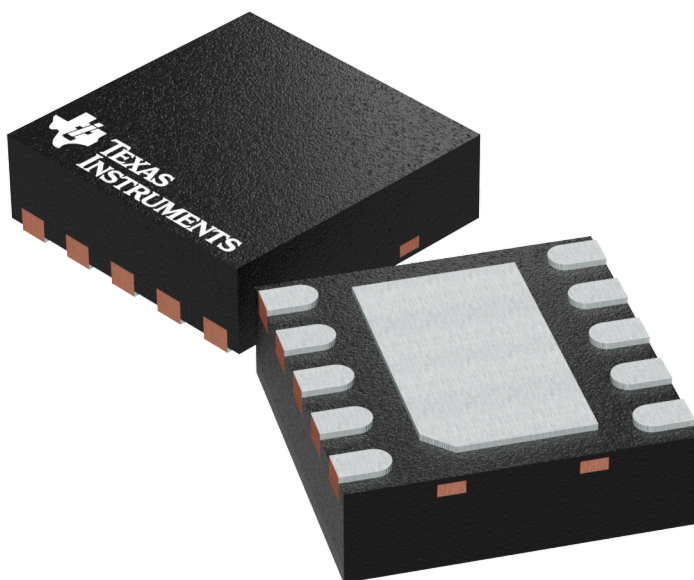| Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS38A752933DSKR	SON	DSK	10	3000	210.0	185.0	35.0
TPS38B752933DSKR	SON	DSK	10	3000	210.0	185.0	35.0

DSK 10 **WSON - 0.8 mm max height**

2.5 x 2.5 mm, 0.5 mm pitch PLASTIC SMALL OUTLINE - NO LEAD

Images above are just a representation of the package family, actual package may vary.
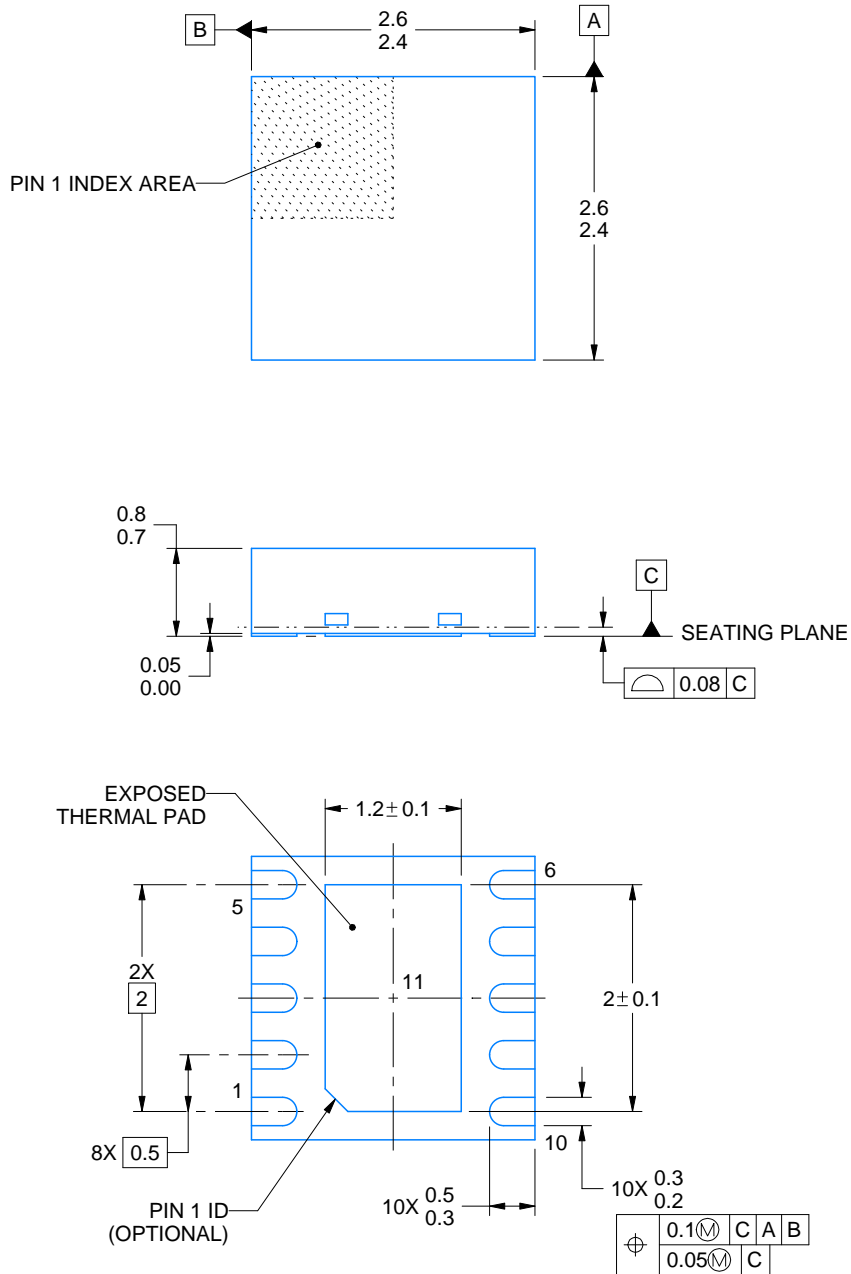Refer to the product data sheet for package details.

4225304/A

TEXAS
INSTRUMENTS

PIN 1 INDEX AREA

B

2.6
2.4

A

2.6
2.4

0.8
0.7

C

SEATING PLANE

0.05
0.00

⌒ 0.08 C

(0.2) TYP

EXPOSED
THERMAL PAD

1.2±0.1

5

6

2X
2

11

2±0.1

1

8X 0.5

10

PIN 1 ID
(OPTIONAL)

10X 0.5
0.3

10X 0.3
0.2

⊕ 0.1 Ⓜ C A B
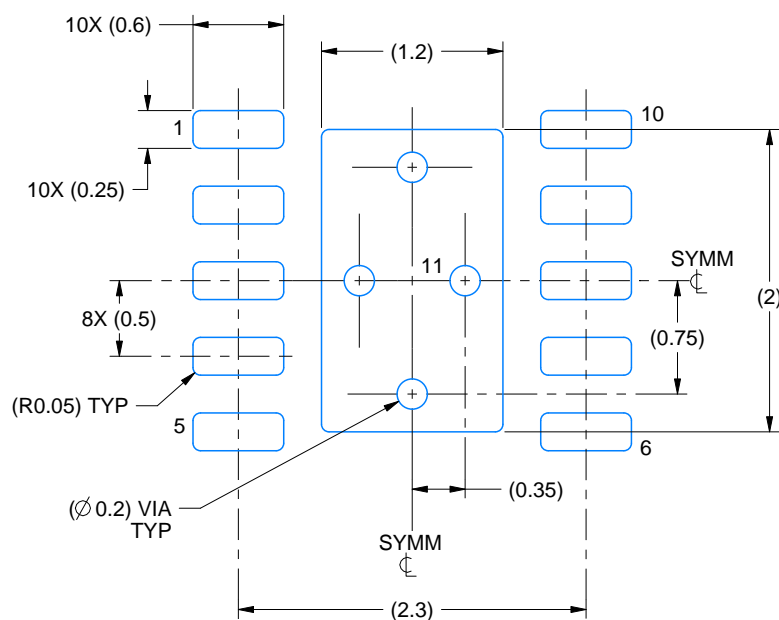0.05 Ⓜ C

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NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.
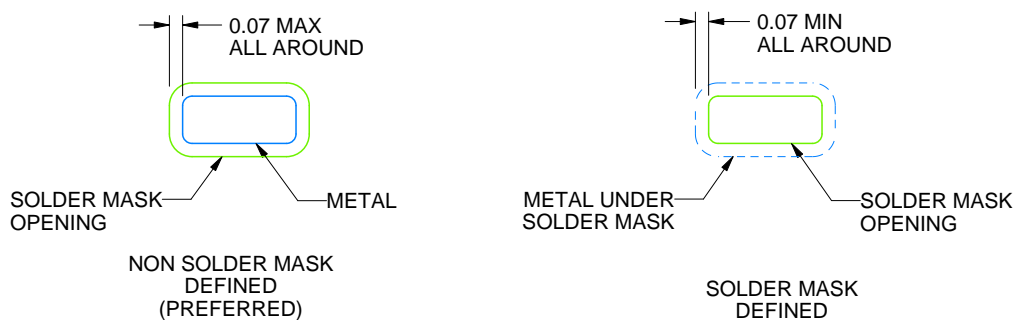
LAND PATTERN EXAMPLE
SCALE:20X

10X (0.6)
(1.2)
10
10X (0.25)
SYMM
(2)
11
(0.75)
8X (0.5)
(R0.05) TYP
5
6
(Ø 0.2) VIA TYP
(0.35)
SYMM
(2.3)

0.07 MAX
ALL AROUND

0.07 MIN
ALL AROUND

SOLDER MASK OPENING — METAL

METAL UNDER SOLDER MASK — SOLDER MASK OPENING

NON SOLDER MASK DEFINED (PREFERRED)

SOLDER MASK DEFINED

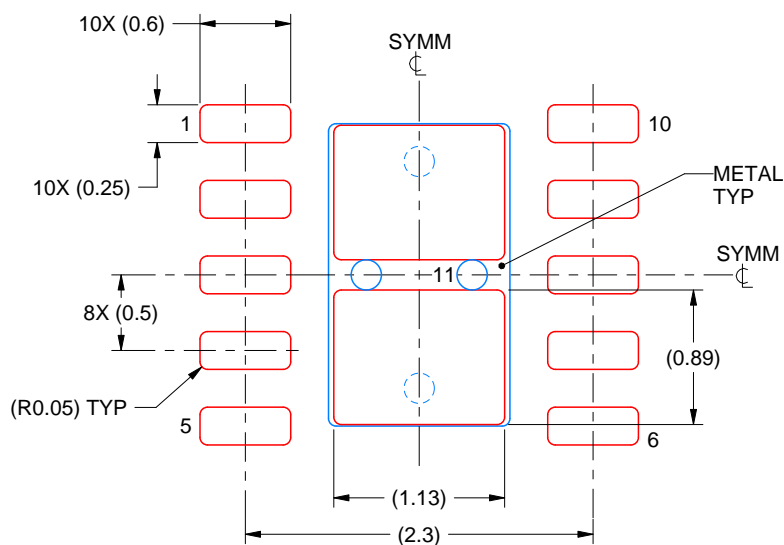SOLDER MASK DETAILS

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NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
5. Vias are optional depending on application, refer to device data sheet. If some or all are implemented, recommended via locations are shown.

10X (0.6)

SYMM

1

10

10X (0.25)

METAL
TYP

SYMM

11

8X (0.5)

(0.89)

(R0.05) TYP

5

6

(1.13)

(2.3)

SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 11
84% PRINTED SOLDER COVERAGE BY AREA
SCALE:20X

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NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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